# TMDXEVM6678L EVM Technical Reference Manual Version 1.0

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This EVM is intended solely for evaluation and development purposes. It is not intended for use and may not be used as all, or part of an end equipment product.

This EVM should be used solely by qualified engineers and technicians who are familiar with the risks associated with handling electrical and mechanical components, systems and subsystems.

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#### **Preface**

#### **About this Document**

This document is a Technical Reference Manual for the TMS320C6678 Evaluation Module (TMDXEVM6678L) designed and developed by Advantech Limited for Texas Instruments, Inc.

#### **Notational Conventions**

This document uses the following conventions:

Program listings, program examples, and interactive displays are shown in a mono spaced font. Examples use **bold** for emphasis, and interactive displays use bold to distinguish commands that you enter from items that the system displays (such as prompts, command output, error messages, etc.).

Square brackets ( [ and ] ) identify an optional parameter. If you use an optional parameter, you specify the information within the brackets. Unless the square brackets are in a bold typeface, do not enter the brackets themselves.

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# **Document Revision History**

| Release | Chapter | Description of Change |
|---------|---------|-----------------------|
| 1.0     | All     | First Release         |
|         |         |                       |
|         |         |                       |

## Acronyms

| Acronym                  | Description   |
|--------------------------|---|
| AMC or AdvancedMC        | Advanced Mezzanine Card                             |
| CCS                      | Code Composer Studio                                |
| DDR3                     | Double Data Rate 3 Interface                        |
| DSP                      | Digital Signal Processor                            |
| DTE                      | Data Terminal Equipment                             |
| EEPROM                   | Electrically Erasable Programmable Read Only Memory |
| EMAC                     | Ethernet Media Access Controller                    |
| EMIF                     | External Memory Interface                           |
| EVM                      | Evaluation Module                                   |
| FPGA                     | Field Programmable Gate Array                       |
| RFU                      | Reserved for Future Use                             |
| I2C                      | Inter Integrated Circuit                            |
| IPMB                     | Intelligent Platform Management Bus                 |
| IPMI                     | Intelligent Platform Management Interface           |
| JTAG                     | Joint Test Action Group                             |
| LED                      | Light Emitting Diode                                |
| MCH                      | MicroTCA Carrier Hub                                |
| MTCA or <i>Micro</i> TCA | Micro Telecommunication Computing Architecture      |
| MMC                      | Module Management Controller                        |
| PICMG®                   | PCI Industrial Computer Manufacturers Group         |
| PCIE                     | PCI express   |
| SDRAM                    | Synchronous Dynamic Random Access Memory            |
| SERDES                   | Serializer-Deserializer                             |
| SGMII                    | Serial Gigabit Media Independent Interface          |
| SRIO                     | Serial RapidIO                                      |
| TSIP                     | Telecom Serial Interface Port                       |
| UART                     | Universal Asynchronous Receiver/Transmitter         |
| USB                      | Universal Serial Bus                                |
| XDS560v2                 | Texas Instruments' System Trace Emulator            |

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#### 1. Overview

This chapter provides an overview of the TMDXEVM6678L along with the key features and block diagram.

- 1.1 Key Features
- 1.2 Functional Overview
- 1.3 Basic Operation
- 1.4 Configuration Switch Settings
- 1.5 Power Supply

#### 1.1 Key Features

The TMDXEVM6678L is a high performance, cost-efficient, standalone development platform that enables users to evaluate and develop applications for the Texas Instruments' TMS320C6678 Digital Signal Processor (DSP). The Evaluation Module (EVM) also serves as a hardware reference design platform for the TMS320C6678 DSP. The EVM's form-factor is equivalent to a single-wide PICMG® AMC.0 R2.0 AdvancedMC module.

Schematics, code examples and application notes are available to ease the hardware development process and to reduce the time to market.

The key features of the TMDXEVM6678L EVM are:

- Texas Instruments' multi-core DSP TMS320C6678
- 512 Mbytes of DDR3-1333 Memory
- 64 Mbytes of NAND Flash
- 16MB SPI NOR FLASH
- Two Gigabit Ethernet ports supporting 10/100/1000 Mbps data-rate one on AMC connector and one RJ-45 connector
- 170 pin B+ style AMC Interface containing SRIO, PCIe, Gigabit Ethernet and TDM
- High Performance connector for HyperLink
- 128K-byte I2C EEPROM for booting
- 2 User LEDs, 5 Banks of DIP Switches and 4 Software-controlled LEDs
- RS232 Serial interface on 3-Pin header or UART over mini-USB connector
- EMIF, Timer, SPI, UART on 80-pin expansion header

- On-Board XDS100 type Emulation using High-speed USB 2.0 interface
- TI 60-Pin JTAG header to support all external emulator types
- Module Management Controller (MMC) for Intelligent Platform Management Interface (IPMI)
- Optional XDS560v2 System Trace Emulation Mezzanine Card
- Powered by DC power-brick adaptor (12V/3.0A) or AMC Carrier backplane
- PICMG® AMC.0 R2.0 single width, full height AdvancedMC module

#### 1.2 Functional Overview

The TMS320C66x™ DSPs (including the TMS320C6678 device) are the highest-performance fixed / floating-point DSP generation in the TMS320C6000™ DSP platform. The TMS320C6678 device is based on the third-generation high-performance, advanced VelociTI™ very-long-instruction-word (VLIW) architecture developed by Texas Instruments (TI), designed specifically for high density wireline / wireless media gateway infrastructure. It is an ideal solution for IP border gateways, video transcoding and translation, video-server and intelligent voice and video recognition applications. The C66x devices are backward code-compatible from previous devices that are part of the C6000™ DSP platform.

The functional block diagram of TMDXEVM6678L is shown in the figure below:

# TIMS320C6678 EVM BLOCK DIAGRAM AMC State | Mini-USB | Mini-USB | Mini-USB | | Mini-US

Figure 1.1: Block Diagram of TMDXEVM6678L EVM

#### 1.3 Basic Operation

The TMDXEVM6678L platform is designed to work with TI's Code Composer Studio (CCS) development environment and ships with a version specifically tailored for this board. CCS can interface with the board via on-board emulation circuitry using the USB cable supplied

along with this EVM or through an external emulator.

The EVM comes with the Texas Instruments Multicore Software Development Kit (MCSDK) for SYS/BIOS OS. The BIOS MCSDK provides the core foundational building blocks that facilitate application software development on TI's high performance and multicore DSPs. The MCSDK also includes an out-of-box demonstration; see the "MCSDK Getting Started Guide".

To start operating the board, follow instructions in the Quick Start Guide. This guide provides instruction for proper connections and configuration for running the POST and OOB Demos. After completing the POST and OOB Demos, proceed with installing CCS and the EVM support files by following the instructions on the DVD. This process will install all the necessary development tools, drivers and documentation.

After the installation has completed, follow the steps below to run Code Composer Studio.

- 1. Power-on the board using the power brick adaptor (12V/3.0A) supplied along with this EVM or inserting this EVM board into a MicroTCA chassis or AMC carrier backplane.
- 2. Connect USB cable from host PC to EVM board.
- 3. Launch Code Composer Studio from host PC by double clicking on its icon on the PC desktop.

Detailed information about the EVM including examples and reference materials are available in the DVD included with this EVM kit.

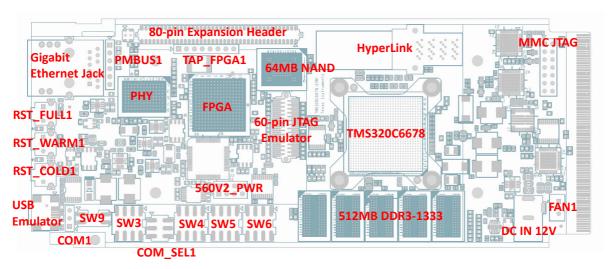


Figure 1.2: TMDXEVM6678L EVM Layout

#### 1.4 Boot Mode and Boot Configuration Switch Setting

The TMDXEVM6678L has 18 sliding DIP switches (Board Ref. SW3 to SW6 and SW9) to determine boot mode, boot configuration, device number, endian mode, CorePac PLL clock selection and PCIe Mode selection options latched at reset by the DSP.

#### 1.5 Power Supply

The TMDXEVM6678L can be powered from a single +12V / 3.0A DC (36W) external power supply connected to the DC power jack (DC\_IN1). Internally, +12V input is converted into required voltage levels using local DC-DC converters.

- CVDD (+0.90V~+1.05V) used for the DSP Core logic
- +1.0V is used for DSP internal memory and HyperLink/SRIO/SGMII/PCIe SERDES termination of DSP
- +1.5V is used for DDR3 buffers of DSP, HyperLink/SRIO/SGMII/PCIe SERDES regulators in DSP and DDR3 DRAM chips
- +1.8V is used for DSP PLLs, DSP LVCMOS I/Os and FPGA I/Os driving the DSP
- +2.5V is used for Gigabit Ethernet PHY core
- +1.2V is used for FPGA core and Gigabit Ethernet PHY core
- +3.3V is used for FPGA I/Os
- +5V and +3.3V is used to power optional XDS560v2 mezzanine card
- The DC power jack connector is a 2.5mm barrel-type plug with center-tip as positive polarity

The TMDXEVM6678L can also draw power from the AMC edge connector (AMC1). If the board is inserted into a PICMG® MicroTCA.0 R1.0 compliant system chassis or AMC Carrier backplane, an external +12V supply from DC jack (DC IN1) is not required.

#### 2. Introduction to the TMDXEVM6678L board

This chapter provides an introduction and details of interfaces for the TMDXEVM6678L board. It contains:

- 2.1 Memory Map
- 2.2 EVM Boot mode and Boot configuration switch settings
- 2.3 JTAG Emulation Overview
- 2.4 Clock Domains
- 2.5 I2C boot EEPROM / SPI NOR Flash
- 2.6 FPGA
- 2.7 Gigabit Ethernet PHY
- 2.8 Serial RapidIO (SRIO) Interfaces
- 2.9 DDR3 External Memory Interfaces
- 2.10 16-bit Asynchronous External Memory Interface
- 2.11 HyperLink Interface
- 2.12 PCle Interface
- 2.13 Telecom Serial Interface Port (TSIP)
- 2.14 UART Interfaces
- 2.15 Module Management Controller for IPMI
- 2.16 Additional Headers

#### 2.1 Memory Map

The memory map of the TMS320C6678 device is as shown in Table 1. The external memory configuration register address ranges in the TMS320C6678 device begin at the hex address location 0x7000 0000 for EMIFA and hex address location 0x8000 0000 for DDR3 Memory Controller.

Table 2.1: TMS320C6678 Memory Map

| Address Range           | Bytes | Memory Block Description                   |
|-------------------------|-------|--|
| 0x00800000 – 0x0087FFFF | 512K  | Local L2 SRAM                              |
| 0x00E00000 – 0x00E07FFF | 32K   | Local L1P SRAM                             |
| 0x00F00000 - 0x00F07FFF | 32K   | L1D SRAM                                   |
| 0x01800000 - 0x01BFFFFF | 4M    | C66x CorePac Registers                     |
| 0x01E00000 - 0x01E3FFFF | 256K  | Telecom Serial Interface Port (TSIP) 0     |
| 0x01E80000 - 0x01EBFFFF | 256K  | Telecom Serial Interface Port (TSIP) 1     |
| 0x02000000 - 0x0209FFFF | 640K  | Packet Accelerator Subsystem Configuration |
| 0x02310000 - 0x023101FF | 512   | PLL Controller                             |
| 0x02320000 - 0x023200FF | 256   | GPIO                                       |
| 0x02330000 – 0x023303FF | 1K    | SmartRlex                                  |
| 0x02350000 - 0x02350FFF | 4K    | Power Sleep Controller (PSC)               |
| 0x02360000 - 0x023603FF | 1K    | Memory Protection Unit (MPU) 0             |
| 0x02368000 - 0x023683FF | 1K    | Memory Protection Unit (MPU) 1             |
| 0x02370000 – 0x023703FF | 1K    | Memory Protection Unit (MPU) 2             |
| 0x02378000 – 0x023783FF | 1K    | Memory Protection Unit (MPU) 3             |
| 0x02530000 – 0x0253007F | 128   | I2C Data & Control                         |
| 0x02540000 – 0x0254003F | 64    | UART                                       |
| 0x02600000 - 0x02601FFF | 8K    | Secondary Interrupt Controller (INTC) 0    |
| 0x02604000 - 0x02605FFF | 8K    | Secondary Interrupt Controller (INTC) 1    |
| 0x02608000 - 0x02609FFF | 8K    | Secondary Interrupt Controller (INTC) 2    |
| 0x0260C000 - 0x0260DFFF | 8K    | Secondary Interrupt Controller (INTC) 3    |
| 0x02620000 - 0x026207F  | 2K    | Chip-Level Registers (boot cfg)            |
| 0x02640000 - 0x026407FF | 2K    | Semaphore                                  |
| 0x02700000 – 0x02707FFF | 32K   | EDMA Channel Controller (TPCC) 0           |
| 0x02720000 – 0x02727FFF | 32K   | EDMA Channel Controller (TPCC) 1           |
| 0x02740000 - 0x02747FFF | 32K   | EDMA Channel Controller (TPCC) 2           |
| 0x02760000 - 0x027603FF | 1K    | EDMA TPCC0 Transfer Controller (TPTC) 0    |
| 0x02768000 - 0x027683FF | 1K    | EDMA TPCC0 Transfer Controller (TPTC) 1    |
| 0x02770000 - 0x027703FF | 1K    | EDMA TPCC1 Transfer Controller (TPTC) 0    |
| 0x02778000 - 0x027783FF | 1K    | EDMA TPCC1 Transfer Controller (TPTC) 1    |
| 0x02780000 - 0x027803FF | 1K    | EDMA TPCC1 Transfer Controller (TPTC) 2    |
| 0x02788000 - 0x027883FF | 1K    | EDMA TPCC1Transfer Controller (TPTC) 3     |
| 0x02790000 – 0x027903FF | 1K    | EDMA TPCC2 Transfer Controller (TPTC) 0    |
| 0x02798000 - 0x027983FF | 1K    | EDMA TPCC2 Transfer Controller (TPTC) 1    |
| 0x027A0000 – 0x027A03FF | 1K    | EDMA TPCC2 Transfer Controller (TPTC) 2    |
| 0x027A8000 – 0x027A83FF | 1K    | EDMA TPCC2 Transfer Controller (TPTC) 3    |
| 0x027D0000 – 0x027D3FFF | 16K   | TI Embedded Trace Buffer (TETB) core 0     |
| 0x027E0000 – 0x027E3FFF | 16K   | TI Embedded Trace Buffer (TETB) core 1     |
| 0x027F0000 – 0x027F3FFF | 16K   | TI Embedded Trace Buffer (TETB) core 2     |
| 0x02800000 – 0x02803FFF | 16K   | TI Embedded Trace Buffer (TETB) core 3     |
| 0x02810000 – 0x02813FFF | 16K   | TI Embedded Trace Buffer (TETB) core 4     |
| 0x02820000 – 0x02823FFF | 16K   | TI Embedded Trace Buffer (TETB) core 5     |

| Address Range             | Bytes | Memory Block Description                  |
|---------------------------|-------|---|
| 0x02830000 - 0x02833FFF   | 16K   | TI Embedded Trace Buffer (TETB) core 6    |
| 0x02840000 - 0x02843FFF   | 16K   | TI Embedded Trace Buffer (TETB) core 7    |
| 0x02850000 - 0x02857FFF   | 32K   | TI Embedded Trace Buffer (TETB) — system  |
| 0x02900000 - 0x02907FFF   | 32K   | Serial RapidIO (SRIO) Configuration       |
| 0x02A00000 - 0x02BFFFFF   | 2M    | Queue Manager Subsystem Configuration     |
| 0x08000000 - 0x0800FFFF   | 64K   | Extended Memory Controller (XMC)          |
|                           |       | Configuration                             |
| 0x0BC00000 – 0x0BCFFFFF   | 1M    | Multicore Shared Memory Controller (MSMC) |
|                           |       | Config                                    |
| 0x0C000000 - 0x0C3FFFFF   | 4M    | Multicore Shared Memory                   |
| 0x10800000 - 0x1087FFFF   | 512K  | Core0 L2 SRAM                             |
| 0x10E00000 - 0x10E07FFF   | 32K   | Core0 L1P SRAM                            |
| 0x10F00000 - 0x10F07FFF   | 32K   | Core0 L1D SRAM                            |
| 0x11800000 - 0x1187FFFF   | 512K  | Core1 L2 SRAM                             |
| 0x11E00000 - 0x11E07FFF   | 32K   | Core1 L1P SRAM                            |
| 0x11F00000 - 0x11F07FFF   | 32K   | Core1 L1D SRAM                            |
| 0x12800000 - 0x1287FFFF   | 512K  | Core2 L2 SRAM                             |
| 0x12E00000 - 0x12E07FFF   | 32K   | Core2 L1P SRAM                            |
| 0x12F00000 - 0x12F07FFF   | 32K   | Core2 L1D SRAM                            |
| 0x13800000 - 0x1387FFFF   | 512K  | Core3 L2 SRAM                             |
| 0x13E00000 - 0x13E07FFF   | 32K   | Core3 L1P SRAM                            |
| 0x13F00000 - 0x13F07FFF   | 32K   | Core3 L1D SRAM                            |
| 0x14800000 - 0x1487FFFF   | 512K  | Core4 L2 SRAM                             |
| 0x14E00000 - 0x14E07FFF   | 32K   | Core4 L1P SRAM                            |
| 0x14F00000 - 0x14F07FFF   | 32K   | Core4 L1D SRAM                            |
| 0x15800000 - 0x1587FFFF   | 512K  | Core5 L2 SRAM                             |
| 0x15E00000 - 0x15E07FFF   | 32K   | Core5 L1P SRAM                            |
| 0x15F00000 – 0x15F07FF F  | 32K   | Core5 L1D SRAM                            |
| 0x16800000 - 0x1687FFFF   | 512K  | Core6 L2 SRAM                             |
| 0x16E00000 - 0x16E07FFF   | 32K   | Core6 L1P SRAM                            |
| 0x16F00000 - 0x16F07FFF   | 32K   | Core6 L1D SRAM                            |
| 0x17800000 - 0x1787FFFF   | 512K  | Core7 L2 SRAM                             |
| 0x17E00000 - 0x17E07FFF   | 32K   | Core7 L1P SRAM                            |
| 0x17F00000 - 0x17F07FFF   | 32K   | Core7 L1D SRAM                            |
| 0x20000000 - 0x200FFFFF   | 1M    | System Trace Manager (STM) Configuration  |
| 0x 20B00000-0x 20B1FFFF   | 128K  | Boot ROM                                  |
| 0x20BF0000-0x 20BF03FF    | 1K    | SPI                                       |
| 0x 20C00000 – 0x 20C000FF | 256   | EMIF-16 Configuration                     |
| 0x 21000000 – 0x 210000FF | 256   | DDR3 EMIF Configuration                   |
| 0x21400000 - 0x214003FF   | 1K    | HyperLink Configuration                   |
| 0x21800000 - 0x21807FFF   | 32K   | PCIe Configuration                        |
| 0x21400000 - 0x214003FF   | 1K    | HyperLink Config                          |
| 0x40000000 – 0x4FFFFFFF   | 2M    | HyperLink data                            |

| Address Range           | Bytes | Memory Block Description    |
|-------------------------|-------|-----------------------------|
| 0x60000000 – 0x6FFFFFFF | 256M  | PCle Data                   |
| 0x70000000 - 0x73FFFFFF | 64M   | EMIF16 CS2 Data NAND Memory |
| 0x74000000 - 0x77FFFFF  | 64M   | EMIF16 CS3 Data NAND Memory |
| 0x78000000 - 0x7BFFFFFF | 64M   | EMIF16 CS4 Data NOR Memory  |
| 0x7C000000 – 0x7FFFFFF  | 64M   | EMIF16 CS5 Data SRAM Memory |
| 0x80000000 – 0x8FFFFFFF | 256M  | DDR3_ Data                  |
| 0x90000000 – 0x9FFFFFF  | 256M  | DDR3_ Data                  |
| 0xA0000000 – 0xAFFFFFF  | 256M  | DDR3_ Data                  |
| 0xB0000000 – 0xBFFFFFFF | 256M  | DDR3_ Data                  |
| 0xC0000000 – 0xCFFFFFF  | 256M  | DDR3_ Data                  |
| 0xD0000000 – 0xDFFFFFFF | 256M  | DDR3_ Data                  |
| 0xE0000000 – 0xEFFFFFFF | 256M  | DDR3_ Data                  |
| 0xF0000000 – 0xFFFFFFFF | 256M  | DDR3_ Data                  |

#### 2.2 EVM Boot Mode and Boot Configuration Switch Settings

The TMDXEVM6678L has five configuration DIP switches: SW3, SW4, SW5, SW6 and SW9 that contain 17 individual values latched when reset is released. This occurs when power is applied the board, after the user presses the FULL\_RESET push button or after a POR reset is requested from the MMC.

SW3 determines general DSP configuration, Little or Big Endian mode and boot device selection.

SW4, SW5, SW6 and SW9 determine DSP boot device configuration, CorePac PLL setting and PCIe mode selection and enable.

More information about using these DIP switches is contained in Section 3.3 of this document. For more information on DSP supported Boot Modes, refer to <a href="https://document.com/document-base-parabolic-left-supported-boot

#### 2.3 JTAG - Emulation Overview

The TMDXEVM6678L has on-board embedded JTAG emulation circuitry; hence users do not require any external emulator to connect EVM with Code Composer Studio. Users can connect CCS with the target DSP on the EVM through the USB cable supplied along with this board.

In case users wish to connect an external emulator to the EVM, the TI 60-pin JTAG header (EMU1) is provided for high speed real-time emulation. The TI 60-pin JTAG supports all standard TI DSP emulators. An adapter will be required for use with some emulators.

The on-board embedded JTAG emulator is the default connection to the DSP. However when an external emulator is connected to EVM, the board circuitry switches automatically to give emulation control to the external emulator.

When the on-board emulator and external emulator both are connected at the same time, the external emulator has priority and the on-board emulator is disconnected from the DSP.

The interface between DSP, on-board and external emulator is shown in below:

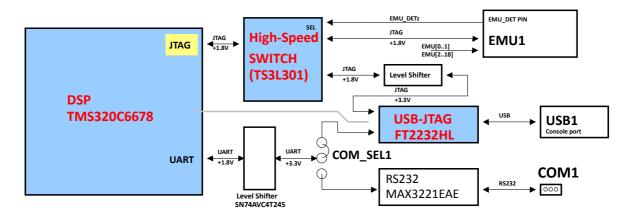


Figure 2.1: TMDXEVM6678L EVM JTAG emulation

#### 2.4 Clock Domains

The EVM incorporates a variety of clocks to the TMS320C6678 as well as other devices which are configured automatically during the power up configuration sequence. The figure below illustrates clocking for the system in the EVM module.

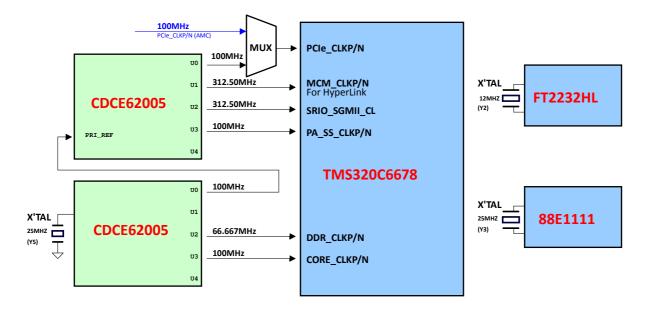


Figure 2.2: TMDXEVM6678L EVM Clock Domains

#### 2.5 I2C Boot EEPROM / SPI NOR Flash

The I2C modules on the TMS320C6678 may be used by the DSP to control local peripheral

ICs (DACs, ADCs, etc.) or may be used to communicate with other controllers in a system or to implement a user interface.

The I2C bus is connected to one SEEPROM and to the 80-pin expansion header (TEST\_PH1). There are two banks in the I2C SEEPROM which respond separately at addresses 0x50 and 0x51. These banks can be loaded with demonstration programs. Currently, the bank at 0x50 contains the I2C boot code and PLL initialization procedure and the bank at 0x51 contains the second level boot-loader program. The second level boot-loader can be used to run the POST program or launch the OOB demonstration from NOR flash memory.

The serial peripheral interconnect (SPI) module provides an interface between the DSP and other SPI-compliant devices. The primary intent of this interface is to allow for connection to a SPI ROM for boot. The SPI module on TMS320C6678 is supported only in Master mode.

The NOR FLASH attached to CSOz on the TMS320C6678 is a NUMONYX N25Q128A21. This NOR FLASH size is 16MB. It can contain demonstration programs such as POST or the OOB demonstration. The CS1z of the SPI is used by the DSP to access registers within the FPGA.

#### **2.6 FPGA**

The FPGA (Xilinx XC3S200AN) controls the reset mechanism of the DSP and provides boot mode and boot configuration data to the DSP through SW3, SW4, SW5, SW6 and SW9. FPGA also provides the transformation of TDM Frame Sync and Clock between AMC connector and the DSP. The FPGA also supports 4 user LEDs and 1 user switch through control registers. All FPGA registers are accessible over the SPI interface.

The figure below shows the interface between TMS320C6678 DSP and FPGA.

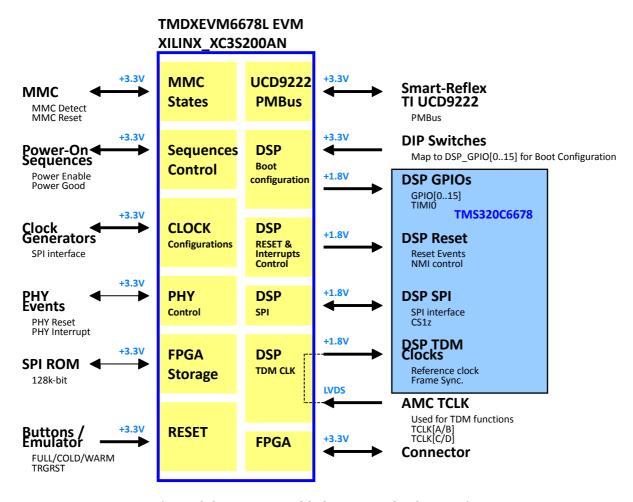


Figure 2.3: TMDXEVM6678L EVM FPGA Connections

#### 2.7 Gigabit Ethernet Connections

The TMDXEVM6678L provides connectivity for both SGMII Gigabit Ethernet ports on the EVM. These are shown in figure below:

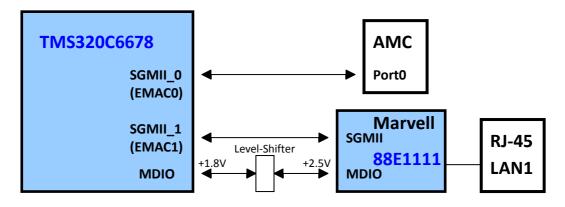


Figure 2.4: TMDXEVM6678L EVM Ethernet Routing

The Ethernet PHY (PHY1) is connected to DSP EMAC1 to provide a copper interface and routed to a Gigabit RJ-45 connector (LAN1). The EMAC0 of DSP is routed to Port0 of the

AMC edge connector backplane interface.

#### 2.8 Serial RapidIO (SRIO) Interface

The TMDXEVM6678L supports high speed SERDES based Serial RapidIO (SRIO) interface. There are total 4 RapidIO ports available on TMS320C6678. All SRIO ports are routed to AMC edge connector on board. Below figure shows RapidIO connections between the DSP and AMC edge connector.

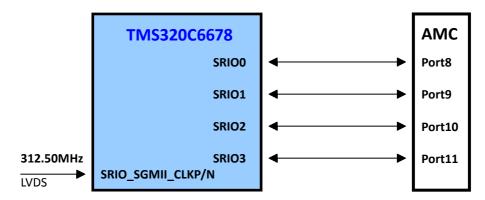


Figure 2.5: TMDXEVM6678L EVM SRIO Port Connections

#### 2.9 DDR3 External Memory Interface

The TMS20C6678 **DDR3 interface** connects to four 1Gbit (64Meg x 16) DDR3 1333 devices. This configuration allows the use of both "narrow (16-bit)", "normal (32-bit)", and "wide (64-bit)" modes of the DDR3 EMIF.

SAMSUNG DDR3 K4B1G1646x-HCH9 SDRAMs (64Mx16; 667Mhz) are used on the DDR3 EMIF.

The figure 2.6 illustrates the implementation for the DDR3 SDRAM memory.

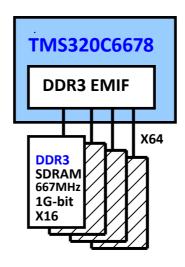


Figure 2.6: TMDXEVM6678L EVM SDRAM

#### 2.10 16-bit Asynchronous External Memory Interface (EMIF-16)

The TMS20C6678 **EMIF-16** interface connects to one 512Mbit (64MB) NAND flash device and 80-pin expansion header (TEST\_PH1) on the TMDXEVM6678L EVM. The EMIF16 module provides an interface between DSP and asynchronous external memories such as NAND and NOR flash. For more information, see the External Memory Interface (EMIF16) for KeyStone Devices User Guide (literature number SPRUGZ3).

NUMONYX NAND512R3A2d NAND flash (64MB) is used on the EMIF-16.

The figure 2.7 illustrates the EMIF-16 connections on the TMDXEVM6678L EVM.

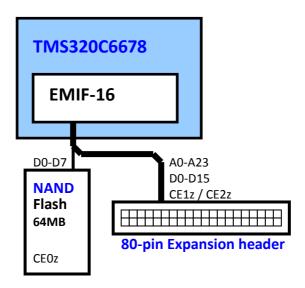


Figure 2.7: TMDXEVM6678L EVM EMIF-16 connections

#### 2.11 HyperLink Interface

The TMS320C6678 provides the HyperLink bus for companion chip/die interfaces. This is a four lane SerDes interface designed to operate at 12.5 Gbps per lane. The interface is used to connect with external accelerators.

The interface includes the Serial Station Management Interfaces used to send power management and flow messages between devices. This consists of four LVCMOS inputs and four LVCMOS outputs configured as two 2-wire output buses and two 2-wire input buses. Each 2-wire bus includes a data signal and a clock signal.

The figure 2.8 illustrates the Hyperlink bus connections on the TMDXEVM6678L EVM.

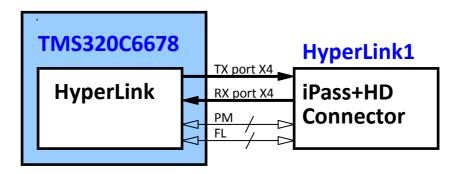


Figure 2.8: TMDXEVM6678L EVM HyperLink connections

#### 2.12 PCIe Interface

The 2 lane PCI express (PCIe) interface on TMDXEVM6678L provides a connection between the DSP and AMC edge connector. The PCI Express interface provides low pin count, high reliability, and high-speed data transfer at rates of 5.0 Gbps per lane on the serial links. For more information, see the Peripheral Component Interconnect Express (PCIe) for KeyStone Devices User Guide (literature number SPRUGS6).

The TMDXEVM6678L provides the PCIe connectivity to AMC backplane on the EVM, this is shown in figure 2.9.

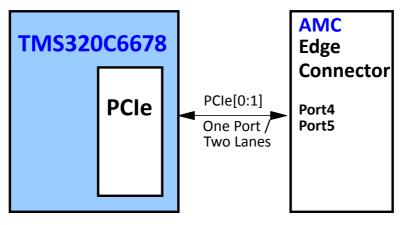


Figure 2.9: TMDXEVM6678L EVM PCIE Port Connections

#### 2.13 Telecom Serial Interface Port (TSIP)

The telecom serial interface port (TSIP) module provides a glueless interface to common telecom serial data streams. For more information, see the Telecom Serial Interface Port (TSIP) for the C66x DSP User Guide (literature number SPRUGY4).

The number of active serial links of the TSIPO and TSIP1 is four and they are connected to the AMC edge connector through a level shift IC to support 3.3V I/O on the TMDXEVM6678L EVM. The serial links support up to 512 8-bit timeslots for each link. The serial data rates supported are 8.192Mbps, 16.384Mbps or 32.768Mbps. Maximum occupation of the serial interface links for the entire TSIP is 1024 transmit and receive timeslots in all configurations.

The figure 2.9 illustrates the TSIPO and TSIP1 connections on the TMDXEVM6678L EVM. The RX and TX ports on the TSIP interfaces are cross-connected to support both interleaved and unidirectional backplane TBM buses.

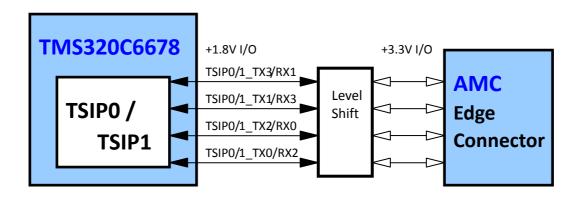


Figure 2.10: TMDXEVM6678L EVM TSIP connections

#### 2.14 UART Interface

A serial port is provided for UART communication by TMS320C6678. This serial port can be accessed either through USB connector (USB1) or through 3-pin (Tx, Rx and Gnd) serial port header (COM1). The selection can be made through UART Route Select shunt-post COM SEL1 as follows:

- UART over mini-USB Connector Shunts installed over COM\_SEL1.3- COM\_SEL1.1 and COM\_SEL1.4 COM\_SEL1.2 (**Default**)
- UART over 3-Pin Header (COM1) Shunts installed over COM\_SEL1.3- COM\_SEL1.5 and COM\_SEL1.4 -COM\_SEL1.6

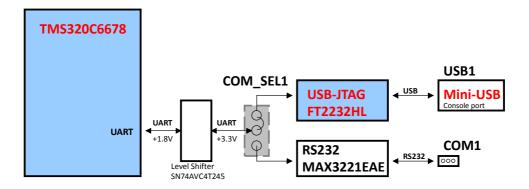


Figure 2.11: TMDXEVM6678L EVM UART Connections

#### 2.15 Module Management Controller (MMC) for IPMI

The TMDXEVM6678L supports a limited set of Intelligent Platform Management Interface (IPMI) commands using Module Management Controller (MMC) based on Texas Instruments MSP430F5435 mixed signal processor.

The MMC will communicate with MicroTCA Carrier Hub (MCH) over IPMB (Intelligent Platform Management Bus) when inserted into an AMC slot of a PICMG® MTCA.0 R1.0 compliant chassis. The primary purpose of the MMC is to provide necessary information to MCH, to enable the payload power to TMDXEVM6678L EVM when it is inserted into the MicroTCA chassis.

The EVM also supports a Blue LED (LED2) and LED1 (LED1, RED) on the front panel as specified in PICMG® AMC.0 R2.0 AdvancedMC base specification. Both of these LEDs will blink as part of initialization process when the MMC will receive management power.

Blue LED (LED2):

Blue LED will turn ON when MicroTCA chassis is powered ON and an EVM is inserted into it. The blue LED will turn OFF when payload power is enabled to the EVM by the MCH.

LED1 (LED1, RED):

Red colored LED1 will normally be OFF. It will turn ON to provide basic feedback about failures and out of service.

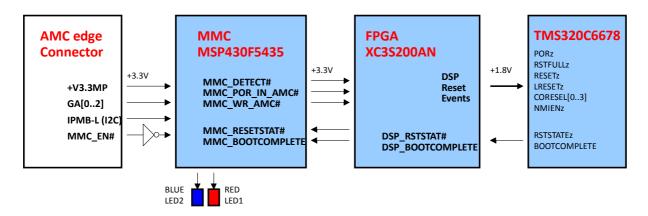


Figure 2.12: TMDXEVM6678L EVM MMC Connections for IPMI

#### 2.16 Expansion Header

The TMDXEVM6678L contains an 80-pin header (TEST\_PH1) which has EMIF, I2C, TIMI[1:0], TIMO[0:1], SPI, GPIO[15:0] and UART signal connections. It should be noted that EMIF, I2C, TIMI[1:0], TIMO[0:1], and SPI GPIO[15:0] connections to this header (TEST\_PH1) are of 1.8V level whereas UART signals are of 3.3V level.

### 3. TMDXEVM6678L Board Physical Specifications

This chapter describes the physical layout of the TMDXEVM6678L board and its connectors, switches and test points. It contains:

- 3.1 Board Layout
- 3.2 Connector Index
- 3.3 Switches
- 3.4 Test Points
- 3.5 System LEDs

#### 3.1 Board Layout

The TMDXEVM6678L board dimension is 7.11" x 2.89" (180.6mm x 73.5mm). It is a 12-layer board and powered through connector DC\_IN1. Figure 3-1 and 3-2 shows assembly layout of the TMDXEVM6678L EVM Board.

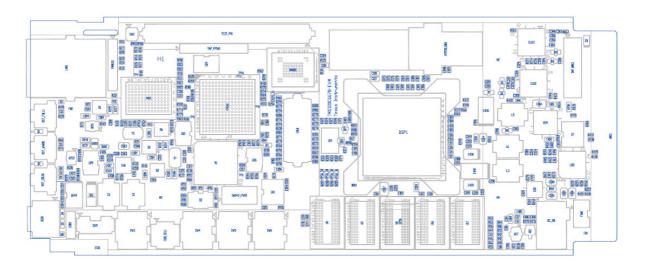


Figure 3.1: TMDXEVM6678L EVM Board Assembly Layout – TOP view

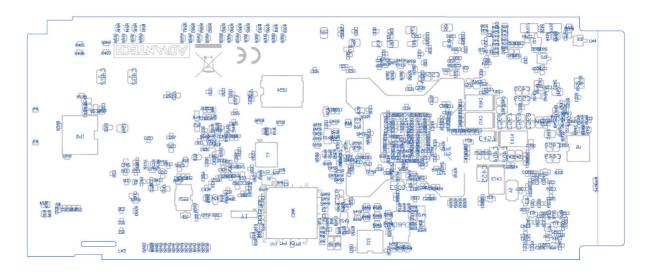


Figure 3.2: TMDXEVM6678L EVM Board layout – Bottom view

#### 3.2 Connector Index

The TMDXEVM6678L Board has several connectors which provide access to various interfaces on the board.

| Connector  | Pins | Function  |
|------------|------|---|
| 560V2_PWR1 | 8    | XDS560v2 Mezzanine Power Connector              |
| AMC1       | 170  | AMC Edge Connector                              |
| COM1       | 3    | UART 3-Pin Connector                            |
| COM_SEL1   | 6    | UART Route Select Jumper                        |
| DC_IN1     | 3    | DC Power Input Jack Connector                   |
| EMU1       | 60   | TI 60-Pin DSP JTAG Connector                    |
| FAN1       | 3    | FAN connector for +12V DC FAN                   |
| HyperLink1 | 36   | HyperLink connector for companion chip/die      |
|            |      | interface                                       |
| LAN1       | 12   | Gigabit Ethernet RJ-45 Connector                |
| PMBUS1     | 5    | PMBUS for Smart-Reflex connected to UCD9222     |
| TAP_FPGA1  | 10   | FPGA JTAG Connector                             |
| TAP_MMC1   | 14   | MSP430 JTAG Connector For Factory Use Only      |
| TEST_PH1   | 80   | EMIF, SPI, I2C, GPIO, TIMI[1:0], TIMO[1:0], and |
|            |      | UART1 connections                               |
| USB1       | 5    | Mini-USB Connector                              |

Table 3.1: TMDXEVM6678L EVM Board Connectors

#### 3.2.1 560V2\_PWR1, XDS560v2 Mezzanine Power Connector

560V2\_PWR1 is an 8-pin power connector for XDS560v2 mezzanine emulator board. The pin out for the connector is shown in the figure below:

Table 3.2: XDS560v2 Power Connector pin out

| Pin # | Signal Name |
|-------|-------------|
| 1     | +5VSupply   |
| 2     | +5VSupply   |
| 3     | XDS560V2_IL |
| 4     | Ground      |
| 5     | +3.3VSupply |
| 6     | +3.3VSupply |
| 7     | Ground      |
| 8     | Ground      |

#### 3.2.2 AMC1, AMC Edge Connector

The AMC card edge connector plugs into an AMC compatible carrier board and provides 4 Serial RapidIO lanes, 2 PCle lanes, 1 SGMII port, 2 4-lane TDM ports and system interfaces to the carrier board. This connector is the 170 pin B+ style. The signals on this connector are shown in the table below:

Table 3.3: AMC Edge Connector

| Pin | Signal            | Pin | Signal |
|-----|-------------------|-----|--------|
| 1   | GND               | 170 | GND    |
| 2   | VCC12             | 169 | NC     |
| 3   | MMC_PS_N1#        | 168 | NC     |
| 4   | VCC3V3_MP_AMC     | 167 | NC     |
| 5   | MMC_GA0           | 166 | NC     |
| 6   | RSVD              | 165 | NC     |
| 7   | GND               | 164 | GND    |
| 8   | RSVD              | 163 | NC     |
| 9   | VCC12             | 162 | NC     |
| 10  | GND               | 161 | GND    |
| 11  | AMC0_SGMII0_TX_DP | 160 | NC     |
| 12  | AMC0_SGMII0_TX_DP | 159 | NC     |
| 13  | GND               | 158 | GND    |
| 14  | AMC0_SGMII0_RX_DP | 157 | NC     |
| 15  | AMC0_SGMII0_RX_DN | 156 | NC     |
| 16  | GND               | 155 | GND    |
| 17  | MMC_GA1           | 154 | NC     |
| 18  | VCC12             | 153 | NC     |
| 19  | GND               | 152 | GND    |
| 20  | NC                | 151 | NC     |
| 21  | NC                | 150 | NC     |
| 22  | GND               | 149 | GND    |
| 23  | NC                | 148 | NC     |
| 24  | NC                | 147 | NC     |
| 25  | GND               | 146 | GND    |

| Pin | Signal            | Pin | Signal                |  |
|-----|-------------------|-----|-----------------------|--|
| 26  | MMC GA2           | 145 | NC                    |  |
| 27  | VCC12             | 144 | NC                    |  |
| 28  | GND               | 143 | GND                   |  |
| 29  | NC                | 142 | NC                    |  |
| 30  | NC                | 141 | NC                    |  |
| 31  | GND               | 140 | GND                   |  |
| 32  | NC                | 139 | TDM CLKD P            |  |
| 33  | NC                | 138 | TDM CLKD N            |  |
| 34  | GND               | 137 | GND                   |  |
| 35  | NC                | 136 | TDM CLKC P            |  |
| 36  | NC                | 135 | TDM CLKC N            |  |
| 37  | GND               | 134 | GND                   |  |
| 38  | NC                | 133 | NC                    |  |
| 39  | NC                | 132 | NC                    |  |
| 40  | GND               | 131 | GND                   |  |
| 41  | MMC ENABLE N      | 130 | DSP SDA AMC           |  |
| 42  | VCC12             | 129 | DSP SCL AMC           |  |
| 43  | GND               | 128 | GND                   |  |
| 44  | AMCC P4 PCIe TX1P | 127 | NC                    |  |
| 45  | AMCC P4 PCIe TX1N | 126 | NC                    |  |
| 46  | GND               | 125 | GND                   |  |
| 47  | AMCC P4 PCIe RX1P | 124 | NC                    |  |
| 48  | AMCC P4 PCIe RX1N | 123 | NC                    |  |
| 49  | GND               | 122 | GND                   |  |
| 50  | AMCC P5 PCIe TX2P | 121 | AMCC P13 TDM1 TX3/RX1 |  |
| 51  | AMCC P5 PCIe TX2N | 120 | AMCC P13 TDM1 TX1/RX3 |  |
| 52  | GND               | 119 | GND                   |  |
| 53  | AMCC_P5_PCIe_RX2P | 118 | AMCC_P13_TDM1_TX2/RX0 |  |
| 54  | AMCC_P5_PCIe_RX2N | 117 | AMCC_P13_TDM1_TX0/RX2 |  |
| 55  | GND               | 116 | GND                   |  |
| 56  | SMB_SCL_IPMBL     | 115 | AMCC_P12_TDM0_TX3/RX1 |  |
| 57  | VCC12             | 114 | AMCC_P12_TDM0_TX1/RX3 |  |
| 58  | GND               | 113 | GND                   |  |
| 59  | NC                | 112 | AMCC_P12_TDM0_TX2/RX0 |  |
| 60  | NC                | 111 | AMCC_P12_TDM0_TX0/RX2 |  |
| 61  | GND               | 110 | GND                   |  |
| 62  | NC                | 109 | AMCC_P11_SRIO4_TXP    |  |
| 63  | NC                | 108 | AMCC_P11_SRIO4_TXN    |  |
| 64  | GND               | 107 | GND                   |  |
| 65  | NC                | 106 | AMCC_P11_SRIO4_RXP    |  |
| 66  | NC                | 105 | AMCC_P11_SRIO4_RXN    |  |
| 67  | GND               | 104 | GND                   |  |
| 68  | NC                | 103 | AMCC_P10_SRIO3_TXP    |  |
| 69  | NC                | 102 | AMCC_P10_SRIO3_TXN    |  |
| 70  | GND               | 101 | GND                   |  |

| Pin | Signal         | Pin | Signal             |
|-----|----------------|-----|--------------------|
| 71  | SMB_SDA_IPMBL  | 100 | AMCC_P10_SRIO3_RXP |
| 72  | VCC12          | 99  | AMCC_P10_SRIO3_RXN |
| 73  | GND            | 98  | GND                |
| 74  | TDM_CLKA_P     | 97  | AMCC_P9_SRIO2_TXP  |
| 75  | TDM_CLKA_N     | 96  | AMCC_P9_SRIO2_TXN  |
| 76  | GND            | 95  | GND                |
| 77  | TDM_CLKB_P     | 94  | AMCC_P9_SRIO2_RXP  |
| 78  | TDM_CLKB_N     | 93  | AMCC_P9_SRIO2_RXN  |
| 79  | GND            | 92  | GND                |
| 80  | PCIE_REF_CLK_P | 91  | AMCC_P8_SRIO1_TXP  |
| 81  | PCIE_REF_CLK_N | 90  | AMCC_P8_SRIO1_TXN  |
| 82  | GND            | 89  | GND                |
| 83  | MMC_PS_N0      | 88  | AMCC_P8_SRIO1_RXP  |
| 84  | VCC12          | 87  | AMCC_P8_SRIO1_RXN  |
| 85  | GND            | 86  | GND                |

#### 3.2.3 COM1, UART3 Pin Connector

COM1 is 3-pin male connector for RS232 serial interface. A 3-Pin female to 9-Pin DTE female cable is supplied with TMDXEVM6678L to connect with the PC.

Table 3.4: UART Connector pin out

| Pin # | Signal Name |
|-------|-------------|
| 1     | Ground      |
| 2     | Transmit    |
| 3     | Receive     |

#### 3.2.4 COM\_SEL1, UART Route Select Connector

UART port can be accessed either through Mini-USB connector (USB1) or through 3-pin RS232 Serial port header (COM1). The selection can be made through UART route select connector COM\_SEL1 as follows:

- UART over USB Connector (Default): Shunts installed over COM\_SEL1.3-COM\_SEL1.1 and COM\_SEL1.4-COM\_SEL1.2
- UART over 3-Pin Header LAN1-Shunts installed over COM\_SEL1.3-COM\_SEL1.5 and COM\_SEL1.4-COM\_SEL1.6

The pin out for the connector is shown in the figure below:

Table 3.5: UART Path Select Connector pin out

| Pin # | Signal Name        | Pin # | Signal Name        |
|-------|--------------------|-------|--------------------|
| 1     | FT2232H (USB Chip) | 2     | FT2232H (USB Chip) |
| 1     | Transmit           | 2     | Receive            |
| 3     | UART Transmit      | 4     | UART Receive       |
| 5     | MAX3221 Transmit   | 6     | MAX3221 Receive    |

#### 3.2.5 DC IN1, DC Power Input Jack Connector

DC\_IN1 is a DC Power-in Jack Connector for the stand-alone application of TMDXEVM6678L. It is a 2.5mm power jack with positive center tip polarity. Do not use this connector if EVM is inserted into MicroTCA chassis or AMC carrier backplane.

#### 3.2.6 EMU1, TI 60-Pin DSP JTAG Connector

EMU1 is a high speed system trace capable TI 60-pin JTAG connector for XDS560v2 type of DSP emulation. The on board switch multiplexes this interface with the on-board XDS100 type emulator. Whenever an external emulator is plugged into EMU1, the external emulator connection will be switched to the DSP. The I/O voltage level on these pins is 1.8V. So any 1.8 V level compatible emulator can be used to interface with the TMS320C6678 DSP. It should be noted that when an external emulator is plugged into this connector (EMU1), on board XDS100 type emulation circuitry will be disconnected from the DSP. The pin out for the connector is shown in figure below:

Table 3.6: DSP JTAG Connector pin out

| Pin # | Signal Name | Pin # | Signal Name |
|-------|-------------|-------|-------------|
| A1    | Ground      | C1    | ID2 (GND)   |
| A2    | Ground      | C2    | EMU18       |
| A3    | Ground      | C3    | TRST#       |
| A4    | Ground      | C4    | EMU16       |
| A5    | Ground      | C5    | EMU15       |
| A6    | Ground      | C6    | EMU13       |
| A7    | Ground      | C7    | EMU11       |
| A8    | Type0 (NC)  | C8    | TCLKRTN     |
| A9    | Ground      | C9    | EMU10       |
| A10   | Ground      | C10   | EMU8        |
| A11   | Ground      | C11   | EMU6        |
| A12   | Ground      | C12   | EMU4        |
| A13   | Ground      | C13   | EMU3        |
| A14   | Ground      | C14   | EMU1        |
| A15   | TRGRST#     | C15   | ID3 (GND)   |
| B1    | ID0 (GND)   | D1    | NC          |
| B2    | TMS         | D2    | Ground      |
| В3    | EMU17       | D3    | Ground      |
| B4    | TDI         | D4    | Ground      |
| B5    | EMU14       | D5    | Ground      |
| В6    | EMU12       | D6    | Ground      |
| В7    | TDO         | D7    | Ground      |
| В8    | TVD (+1.8V) | D8    | Type1 (GND) |
| В9    | EMU9        | D9    | Ground      |
| B10   | EMU7        | D10   | Ground      |
| B11   | EMU5        | D11   | Ground      |
| B12   | TCLK        | D12   | Ground      |
| B13   | EMU2        | D13   | Ground      |
| B14   | EMU0        | D14   | Ground      |
| B15   | ID1 (GND)   | D15   | Ground      |

#### 3.2.7 FAN1, FAN Connector

The EVM incorporates a dedicated cooling fan. This fan has the capability of easily being removed when the EVM is inserted into an AMC backplane which uses forced air cooling. The fan selected provides maximum cooling (CFM) and operates on 12Vdc. FAN1 will be connected to provide 12Vdc to the fan.

Table 3.7: FAN1 Connector pin out

| Pin # | Signal Name |
|-------|-------------|
| 1     | GNG         |
| 2     | +12Vdc      |
| 3     | NC          |

#### 3.2.8 HyperLink1, HyperLink Connector

The EVM provides a HyperLink connection by a mini-SAS HD+ 4i connector. The connector contains 8 SERDES pairs and 4 sideband sets to carry full HyperLink signals. The connector is shown in Figure 3.3. and its pin out is shown in Table 3.8.

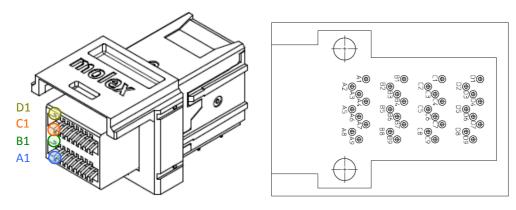


Figure 3.3: The HyperLink Connector

| Pin#       | Net               | Pin# | Net               |
|------------|-------------------|------|-------------------|
| A1         | HyperLink_TXFLCLK | B1   | HyperLink_RXPMDAT |
| A2         | HyperLink_RXFLCLK | B2   | HyperLink_TXFLDAT |
| А3         | GND               | В3   | GND               |
| A4         | HyperLink_RXP1    | B4   | HyperLink_RXP0    |
| A5         | HyperLink_RXN1    | B5   | HyperLink_RXN0    |
| A6         | GND               | В6   | GND               |
| A7         | HyperLink_RXP3    | В7   | HyperLink_RXP2    |
| A8         | HyperLink_RXN3    | B8   | HyperLink_RXN2    |
| A9         | GND               | В9   | GND               |
| C1         | HyperLink_TXPMDAT | D1   | HyperLink_RXPMCLK |
| C2         | HyperLink_TXPMCLK | D2   | HyperLink_RXFLDAT |
| C3         | GND               | D3   | GND               |
| C4         | HyperLink_TXP1    | D4   | HyperLink_TXP0    |
| C5         | HyperLink_TXN1    | D5   | HyperLink_TXN0    |
| C6         | GND               | D6   | GND               |
| C7         | HyperLink_TXP3    | D7   | HyperLink_TXP2    |
| C8         | HyperLink_TXN3    | D8   | HyperLink_TXN2    |
| <b>C</b> 9 | GND               | D9   | GND               |

Table 3.8 : The HyperLink Connector

#### 3.2.9 LAN1, Ethernet Connector

LAN1 is a Gigabit RJ45 Ethernet connector with integrated magnetics. It is driven by Marvell Gigabit Ethernet transceiver 88E1111. The connections are shown in the table below:

Table 3.9: Ethernet Connector pin out

| Pin # | Signal Name    |
|-------|----------------|
| 1     | Center Tap2    |
| 2     | MD2-           |
| 3     | MD2+           |
| 4     | MD1-           |
| 5     | MD1+           |
| 6     | Center Tap1    |
| 7     | Center Tap3    |
| 8     | MD3+           |
| 9     | MD3-           |
| 10    | MD0-           |
| 11    | MD0+           |
| 12    | Center Tap0    |
| 13    | ACT_LED1-      |
| 14    | ACT_LED1+      |
| 15    | LINK1000_LED2- |
| 16    | LINK_LED2+     |
| 17    | LINK100_LED2-  |
| Н3    | Shield 1       |
| H4    | Shield 2       |

#### 3.2.10 PMBUS1, PMBUS Connector for Smart-Reflex Control

The TMS320C6678 DSP core power is supplied by a Smart-Reflex power controller UCD9222 with the Integrated FET Driver UCD7242. PMBUS1 provides a connection between UCD9222 and remote connection during development. Through the USB to GPIO pod provided by TI, the user can trace and configure the parameters in UCD9222 with the Smart-Fusion GUI. The pin out of PMBUS1 is shown in table 3.10.

Table 3.10: PMBUS1 pin out

| Pin # | Signal Name |
|-------|-------------|
| 1     | VCC3V3_AUX  |
| 2     | PMBUS_CLK   |
| 3     | PMBUS_DAT   |
| 4     | PMBUS_ALT   |
| 5     | PMBUS_CTL   |
| 6     | GND         |

### 3.2.11 TAP\_FPGA1, FPGA JTAG Connector (For Factory Use Only)

TAP\_FPGA1 is an 8-pin JTAG connector for the FPGA programming and the PHY boundary test of the factory only. The pin out for the connector is shown in the figure below:

Table 3.11: FPGA JTAG Connector pin out

| Pin # | Signal Name   |  |  |
|-------|---------------|--|--|
| 1     | VCC3V3_FPGA   |  |  |
| 2     | GND           |  |  |
| 3     | BSC_JTAG_TCK  |  |  |
| 4     | BSC_JTAG_RST# |  |  |
| 5     | BSC_JTAG_TDO  |  |  |
| 6     | BSC_JTAG_TDI  |  |  |
| 7     | BSC_JTAG_TMS  |  |  |
| 8     | NC            |  |  |

The diagram of the boundary scan route is shown in Figure 3.4.

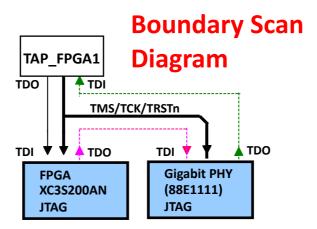


Figure 3.4: TAP\_FPGA1 function diagram

### 3.2.12 TAP\_MMC1, MSP430 JTAG Connector (For Factory Use Only)

TAP\_MMC1 is a 14-pin JTAG connector for IPMI software loading into MSP430. The TMDXEVM6678L are supplied with IPMI software already loaded into MSP430. The pin out for the connector is shown in the figure below:

Table 3.12: MSP430 JTAG Connector pin out

| Pin # | Signal Name | Pin # | Signal Name |
|-------|-------------|-------|-------------|
| 1     | MMC_TDO     | 2     | VCCTOOL(NC) |
| 3     | MMC_TDI     | 4     | VCC         |
| 5     | MMC_TMS     | 6     | NC (Key)    |
| 7     | MMC_TCK     | 8     | MMC_TEST    |
| 9     | GND         | 10    | NC          |
| 11    | MMC_RST_N   | 12    | NC          |
| 13    | NC          | 14    | NC          |

# 3.2.13 TEST\_PH1, Expansion Header (EMIF-16, SPI, GPIO, Timer I/O, I2C, and UART)

TEST\_PH1 is an expansion header for several interfaces on the DSP. They are 16-bit EMIF, SPI, GPIO, Timer, I2C, and UART. The signal connections to the test header are as shown in a table below:

Table 3.13: Test Header pin out

| Pin | Signal      | Description   | Pin | Signal      | Description |
|-----|-------------|---------------|-----|-------------|-------------|
| 1   | GND         | Ground        | 2   | DSP_EMIFA00 | EMIF addr0  |
| 3   | DSP_SDA     | DSP I2C data  | 4   | DSP_EMIFA01 | EMIF addr1  |
| 5   | DSP_SCL     | DSP I2C clock | 6   | DSP_EMIFA02 | EMIF addr2  |
| 7   | DSP_EMIFD0  | EMIF data0    | 8   | DSP_EMIFA03 | EMIF addr3  |
| 9   | DSP_EMIFD1  | EMIF data1    | 10  | DSP_EMIFA04 | EMIF addr4  |
| 11  | DSP_EMIFD2  | EMIF data2    | 12  | DSP_EMIFA05 | EMIF addr5  |
| 13  | DSP_EMIFD3  | EMIF data3    | 14  | DSP_EMIFA06 | EMIF addr6  |
| 15  | DSP_EMIFD4  | EMIF data4    | 16  | DSP_EMIFA07 | EMIF addr7  |
| 17  | DSP_EMIFD5  | EMIF data5    | 18  | DSP_EMIFA08 | EMIF addr8  |
| 19  | DSP_EMIFD6  | EMIF data6    | 20  | DSP_EMIFA09 | EMIF addr9  |
| 21  | DSP_EMIFD7  | EMIF data7    | 22  | DSP_EMIFA10 | EMIF addr10 |
| 23  | DSP_EMIFD8  | EMIF data8    | 24  | DSP_EMIFA11 | EMIF addr11 |
| 25  | DSP_EMIFD9  | EMIF data9    | 26  | DSP_EMIFA12 | EMIF addr12 |
| 27  | DSP_EMIFD10 | EMIF data10   | 28  | DSP_EMIFA13 | EMIF addr13 |
| 29  | DSP_EMIFD11 | EMIF data11   | 30  | DSP_EMIFA14 | EMIF addr14 |
| 31  | DSP_EMIFD12 | EMIF data12   | 32  | DSP_EMIFA15 | EMIF addr15 |
| 33  | DSP_EMIFD13 | EMIF data13   | 34  | DSP_EMIFA16 | EMIF addr16 |
| 35  | DSP_EMIFD14 | EMIF data14   | 36  | DSP_EMIFA17 | EMIF addr17 |

| Pin | Signal        | Description                     | Pin | Signal      | Description |
|-----|---------------|---------------------------------|-----|-------------|-------------|
| 37  | DSP_EMIFD15   | EMIF data15                     | 38  | DSP_EMIFA18 | EMIF addr18 |
| 39  | DSP_EMIFCE1z  | EMIF Space Enable1              | 40  | DSP_EMIFA19 | EMIF addr19 |
| 41  | DSP_EMIFCE2z  | EMIF Space Enable2              | 42  | DSP_EMIFA20 | EMIF addr20 |
| 43  | DSP_EMIFBE0z  | EMIF Byte Enable0               | 44  | DSP_EMIFA21 | EMIF addr21 |
| 45  | DSP_EMIFBE1z  | EMIF Byte Enable1               | 46  | DSP_EMIFA22 | EMIF addr22 |
| 47  | DSP_EMIFOEz   | EMIF Output Enable              | 48  | DSP_EMIFA23 | EMIF addr23 |
| 49  | DSP_EMIFWEz   | EMIF Write Enable               | 50  | DSP_GPIO_00 | DSP GPIO0   |
| 51  | DSP_EMIFRNW   | EMIF Read/Write                 | 52  | DSP_GPIO_01 | DSP GPIO1   |
| 53  | DSP_EMIFWAIT1 | EMIF Wait                       | 54  | DSP_GPIO_02 | DSP GPIO2   |
| 55  | DSP_TIMI0     | Timer input 0                   | 56  | DSP_GPIO_03 | DSP GPIO3   |
| 57  | DSP_TIMO0     | Timer output 0                  | 58  | DSP_GPIO_04 | DSP GPIO4   |
| 59  | DSP_TIMI1     | Timer input 1                   | 60  | DSP_GPIO_05 | DSP GPIO5   |
| 61  | DSP_TIMO1     | Timer output 1                  | 62  | DSP_GPIO_06 | DSP GPIO6   |
| 63  | DSP_SSPMISO   | SPI data input                  | 64  | DSP_GPIO_07 | DSP GPIO7   |
| 65  | DSP_SSPMOSI   | SPI data output                 | 66  | DSP_GPIO_08 | DSP GPIO8   |
| 67  | DSP_SSPCS1    | SPI chip select                 | 68  | DSP_GPIO_09 | DSP GPIO9   |
| 69  | PH_SSPCK      | SPI clock                       | 70  | DSP_GPIO_10 | DSP GPIO10  |
| 71  | DSP_UARTTXD   | UART Serial Data Out<br>(+3.3v) | 72  | DSP_GPIO_11 | DSP GPIO11  |
| 73  | DSP_UARTRXD   | UART Serial Data In<br>(+3.3v)  | 74  | DSP_GPIO_12 | DSP GPIO12  |
| 75  | DSP_UARTRTS   | UART Request To<br>Send (+3.3v) | 76  | DSP_GPIO_13 | DSP GPIO13  |
| 77  | DSP_UARTCTS   | UART Cear To Send<br>(+3.3v)    | 78  | DSP_GPIO_14 | DSP GPIO14  |
| 79  | GND           | Ground                          | 80  | DSP_GPIO_15 | DSP GPIO15  |

# 3.2.14 USB1, Mini-USB Connector

USB1 is a 5-pin Mini-USB connector to connect Code Composer Studio with TMS320C6678 DSP using XDS100 type on-board emulation circuitry. Below table shows the pin outs of the Mini-USB connector.

Table 3.14: Mini-USB Connector pin out

| Pin # | Signal Name |
|-------|-------------|
| 1     | VBUS        |
| 2     | USB D-      |
| 3     | USB D+      |
| 4     | ID (NC)     |
| 5     | Ground      |

#### 3.3 DIP and Pushbutton Switches

The TMDXEVM6678L has 3 push button switches and five sliding actuator DIP switches. The RST\_FULL1, RST\_COLD1, and RST\_WARM1 are push button switches while SW3, SW4, SW5, SW6 and SW9 are DIP switches. The function of each of the switches is listed in the table below:

Table 3.15: TMDXEVM6678L EVM Board Switches

| Switch    | Function                         |
|-----------|----------------------------------|
| RST_FULL1 | Full Reset Event                 |
| RST_COLD1 | Cold Reset Event (RFU)           |
| RST_WARM1 | Warm Reset Event                 |
| SW3       | DSP Boot mode, DSP Configuration |
| SW4       | DSP boot Configuration           |
| SW5       | DSP boot Configuration           |
| SW6       | DSP boot Configuration, PLL      |
| 3000      | setting, PCIe mode Selection     |
| SW9       | PCIe Enable/Disable, User Switch |

#### 3.3.1 RST\_FULL1, Full Reset

Pressing the RST\_FULL1 button switch will issue a RESETFULL# to TMS320C6678 by the FPGA. It'll reset DSP and other peripherals.

### 3.3.2 RST\_COLD1, Cold Reset

The button is reserved for future use.

#### 3.3.3 RST\_WARM1, Warm Reset

Pressing the RST\_WARM1 button switch will issue a RESET# to TMS320C6678 by the FPGA. The FPGA will assert the RESET# signal to the DSP and the DSP will execute either a HARD or SOFT reset by the configuration in the RSCFG register in PLLCTL.

Note: Users may refer to the <u>TMS320C6678 Data Manual</u> to check the difference between assertion of DSP RESET# and the other reset signals.

#### 3.3.4 SW3, SW4, SW5, and SW6, DSP boot mode and Configuration

SW3, SW4, SW5, and SW6 are 4-position DIP switches, which are used for DSP ENDIAN,

Boot Device, Boot Configuration, and PCI Express subsystem configuration.

For the details about the DSP Boot modes and their configuration, please refer to the TMS320C6678 Data Manual.

The diagram of the default setting on these switches is shown below:

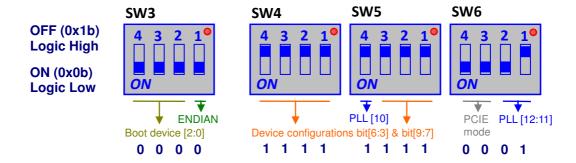


Figure 3.5: SW3, SW4, SW5, and SW6 default settings

The following table describes the positions and corresponding functions on SW1.

Table 3.16: SW3-SW6, DSP Configuration Switch

| SW3                  | Description                               | Default Value        | Function   |
|----------------------|---|----------------------|--|
| SW3[1]               | ENDIAN                                    | 0x0b (ON)            | Device endian mode (LENDIAN).  0 = Device operates in big endian mode  1 = Device operates in little endian mode   |
| SW3[4:2]             | Boot device Bit [2:0]                     | 0x000b(ON)           | Boot Device  000b = EMIF16 and Emulation Boot  001b = Serial Rapid I/O  010b = SGMII (PA driven from core clk)  011b = SGMII (PA driver from PA clk)  100b = PCI Express  101b = I2C  110b = SPI  111b = HyperLink               |
| SW4-6                | Description                               | Default Value        | Function   |
| SW5[3:1]<br>SW4[4:1] | Device<br>Configuration<br>Bit [9:7][6:3] | 0x111 1111b<br>(OFF) | These settings are corresponded to EMIF16 of boot device:  1. Wait enable enabled,  2. EMIF16, not in Sleep mode. For the details about the device configuration, please refer to the chapter 2.5.2 in  TMS320C6678 Data Manual. |
| SW6[2:1]<br>SW5[4]   | PLL Settings Bit[12:10]                   | 0x011b               | C66x DSP System PLL Configuration 00 0b = 50.00 MHz 00 1b = 66.67 MHz 01 0b = 80.00 MHz  01 1b = 100.00 MHz 10 0b = 156.25 MHz 10 1b = 250.00 MHz 11 0 b = 312.50 MHz 11 1b = 122.88 MHz   |
| SW6[4:3]             | PCIESSMODE<br>[1:0]                       | 0x00b(ON)            | PCIe Subsystem mode selection.  00 = PCIe in end point mode  01 = PCIe legacy end point (no support for MSI)  10 = PCIe in root complex mode  11 = Reserved  |

# 3.3.4 SW9, DSP PCIESS Enable and User Defined Switch Configuration

SW9 is a 2-position DIP switch. The first position is used for enabling the PCI Express Subsystem within the DSP. The second position is undefined by hardware and available for application software use. A diagram of the SW9 switch (with factory default settings) is shown below:

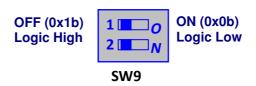


Figure 3.6: SW9 default settings

The following table describes the positions and corresponding functions on SW9.

Table 3.17: SW9, DSP PCI Express Enable and User Switch

| SW9    | Description | Default Value | Function   |
|--------|-------------|---------------|--|
| SW9[1] | PCIESSEN    | 0x1b (OFF)    | PCIe module enable.  0 = PCIe module disabled  1 = PCIe module enabled |
| SW9[2] | User Switch | 0x1b (OFF)    | Application software defined   |

### 3.4 Test Points

The TMDXEVM6678L EVM Board has 13 test points. The position of each test point is shown in the figures below:

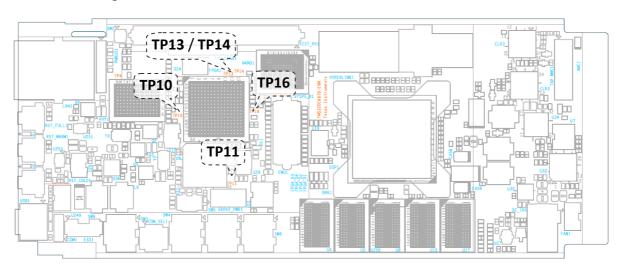


Figure 3.7: TMDXEVM6678L test points on top side

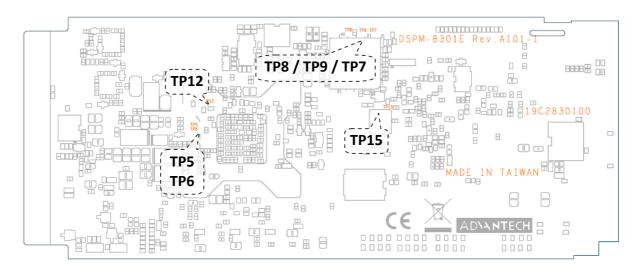


Figure 3.8: TMDXEVM6678L test points on the bottom side

Table 3.18: TMDXEVM6678L EVM Board Test Points

| Test Point | Signal  |
|------------|---|
| TP7        | Reserved for MMC1 pin23                             |
| TP8        | Reserved for MMC1 pin33                             |
| TP9        | Reserved for MMC1 pin25                             |
| TP5        | HyperLink_REFCLKOUTP                                |
| TP6        | HyperLink_REFCLKOUTN                                |
| TP12       | DSP_SYSCLKOUT                                       |
| TP10       | Reserved for U9 (FT2232) pin60 (PWREN#)             |
| TP11       | Reserved for U9 (FT2232) pin36 (SUSPEND#)           |
| TP4        | PHY1 (88E1111) 125MHz clock (default: disable)      |
| TP13       | Reserved for FPGA1 (XC3S200AN) pin A13 (+1.8V I/O). |
| TP14       | Reserved for FPGA1 (XC3S200AN) pin A14 (+1.8V I/O). |
| TP15       | Reserved for FPGA1 (XC3S200AN) pin M14 (+3.3V I/O). |
| TP16       | Reserved for FPGA1 (XC3S200AN) pin L16 (+3.3V I/O). |

# 3.5 System LEDs

The TMDXEVM6678L board has seven LEDs. Their positions on the board are indicated in figure 3.7. The description of each LED is listed in table below:

Table 3.19: TMDXEVM6678LTEEVM Board LEDs

| LED#     | Color | Description                                      |
|----------|-------|--|
| D1       | Red   | Failure and Out of service status in AMC chassis |
| D2       | Blue  | Hot Swap status in AMC chassis                   |
| SYSPG_D1 | Green | All Power rails are stable on AMC                |
| FPGA_D1- | Blue  | Debug LEDs                                       |
| FPGA_D4  | Blue  | Debug LEDs.                                      |

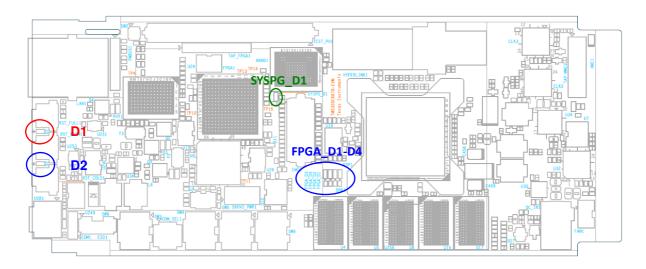


Figure 3.9: TMDXEVM6678L EVM Board LEDs

# 4. System Power Requirements

This chapter describes the power design of the TMDXEVM6678L board. It contains:

- 4.1 Power Requirements
- 4.2 Power Supply Distribution
- 4.3 Power Supply Boot Sequence

# **4.1 Power Requirements**

EVM board total: 31.2W;

Note that the power estimates stated in this section are maximum limits used in the design of the EVM. They have margin added to allow the EVM to support early silicon samples that normally have higher power consumption than eventual production units.

The maximum EVM power requirements are estimated to be:

```
EVM FPGA – 0.65W;
DSP Cooling Fans – 1.2W (+12Vdc/0.1A);
Clock Generators & clock sources – 3.30W;
DSP – 14.90W; [worse case]

Core supplies: 13.0W;
Peripheral supplies: 1.90W;

DDR3 – 2.63W;

SDRAMs to support 64-bit with ECC of the DSP

Misc – 0.33W;
USB – 0.84W;
SGMII PHY – 1.14W;
```

The selected AC/DC 12V adapter should be rated for a minimum of 36 Watts.

# The power planes in TMDXEVM6678L are identified in the following table:

| Device          | Net name    | Voltage     | Description                      |
|-----------------|-------------|-------------|----------------------------------|
| Input           | 3.3V_MP_AMC | +3.3V       | Management Power for MMC         |
|                 | VCC12       | +12V        | Payload Power to AMC             |
| Management      | VCC3V3_AUX  | +3.3V       | 3.3V Power Rail for all support  |
|                 |             |             | devices on EVM                   |
|                 | VCC1V2      | +1.2V       | 1.2V Power Rail for all support  |
|                 |             |             | devices on EVM                   |
|                 | VCC1V8_AUX  | +1.8V       | 1.8V Power Rail for all support  |
|                 |             |             | devices on EVM                   |
| TMS320C6678     | CVDD        | +0.9V~1.05V | DSP Core Power                   |
|                 | VCC1V0      | +1.0V       | DSP Fixed Core Power             |
|                 | VCC1V8      | +1.8V       | DSP I/O power                    |
|                 | VCC1V5      | +1.5V       | DSP DDR3 and SERDES Power        |
| DDR3 Memory     | VCC1V5      | +1.5V       | DDR3 RAM Power                   |
|                 | VCC0V75     | +0.75V      | DDR3 RAM Termination Power       |
| NAND Flash      | VCC1V8      | +1.8V       | NAND Flash Power                 |
| NOR Flash (SPI) | VCC1V8      | +1.8V       | SPI NOR Flash Power              |
| CDCE62005       | VCC3V3_AUX  | +3.3V       | Clock Gen Power                  |
| PHY (88E111)    | VCC2V5      | +2.5V       | PHY Analog and I/O Power         |
|                 | VCC1V2      | +1.2V       | PHY Core Power (instead of 1.0V) |
| USB Emulator    | VCC3V3_AUX  | +3.3V       | USB Emulation Power (FT2232H)    |
|                 | VCC1V8_AUX  | +1.8V       | USB Emulation Power (FT2232H)    |
| MMC (MPS430)    | VCC3V3_MP   | +3.3V       | MMC Power                        |
| FPGA            | VCC1V2      | +1.2V       | FPGA Core Power                  |
|                 | VCC3V3_AUX  | +3.3V       | FPGA I/O Power for +3.3V bank    |
|                 | VCC1V8_AUX  | +1.8V       | FPGA I/O Power for +1.8V bank    |
| Misc. Logic     | VCC3V3_AUX  | +3.3V       | Translator and Logic Power       |
|                 | VCC1V8_AUX  | +1.8V       | Translator and Logic Power       |

Table 4.1: EVM Voltage Table

The following table identifies the expected power requirements for each power plane of the devices on the TMDXEVM6678L EVM.

| TMS320C6678   | V(V) | I(A) | Qty | Pd (W) |       |  |
|---------------|------|------|-----|--------|-------|--|
| CVDD          | 1.00 | 8.00 | 1   | 8.00   |       |  |
| VCC1V0        | 1.00 | 5.00 | 1   | 5.00   | 14.87 |  |
| VCC1V8        | 1.80 | 0.33 | 1   | 0.59   | 14.07 |  |
| VCC1V5        | 1.50 | 0.85 | 1   | 1.28   |       |  |
| DDR3          | V(V) | I(A) | Qty | Pd(    | W)    |  |
| VCC1V5        | 1.50 | 0.30 | 5   | 2.25   | 2.63  |  |
| VCC0V75       | 0.75 | 0.10 | 5   | 0.38   | 2.03  |  |
| FPGA          | V(V) | I(A) | Qty | Pd(    | W)    |  |
| VCC3V3_AUX    | 3.30 | 0.03 | 1   | 0.10   |       |  |
| VCC1V2        | 1.20 | 0.13 | 1   | 0.16   | 0.62  |  |
| VCC1V8_AUX    | 1.80 | 0.20 | 1   | 0.36   |       |  |
| XDS560V2      | V(V) | I(A) | Qty | Pd(W)  |       |  |
| VCC5          | 5.00 | 1.00 | 1   | 5.00   | 5.99  |  |
| VCC3V3_AUX    | 3.30 | 0.30 | 1   | 0.99   | 3.33  |  |
| CDCE62005     | V(V) | I(A) | Qty | Pd(    | W)    |  |
| VCC3V3_AUX    | 3.30 | 0.50 | 2   | 3.30   | 3.30  |  |
| PHY (88E1111) | V(V) | I(A) | Qty | Pd(    | W)    |  |
| VCC2V5_AUX    | 3.30 | 0.21 | 1   | 0.69   | 1.14  |  |
| VCC1V2_AUX    | 1.80 | 0.25 | 1   | 0.45   | 1.14  |  |
| FT2232        | V(V) | I(A) | Qty | Pd(W)  |       |  |
| VCC3V3_AUX    | 3.30 | 0.21 | 1   | 0.69   | 0.84  |  |
| VCC1V8_AUX    | 1.80 | 0.08 | 1   | 0.14   | 0.04  |  |
| MMC (MSP430)  | V(V) | I(A) | Qty | Pd(W)  |       |  |
| VCC3V3_MP     | 3.30 | 0.02 | 1   | 0.07   | 0.07  |  |

Table 4.2: Each Current Requirements on each device of EVM board

# **4.2 The Power Supply Distribution**

A high-level block diagram of the power supplies is shown in Figure 4.1. It is also shown on the schematic.

In Figure 4.1, the Auxiliary power rails are always on after payload power is supplied. These regulators support all control, sequencing, and boot logic. The Auxiliary Power rails contain:

- VCC3V3\_AUX
- VCC1V8 AUX
- VCC1V2
- VCC5\_AUX

The maximum allowable power is 36W from the external AC brick supply or from the 8 AMC header pins.

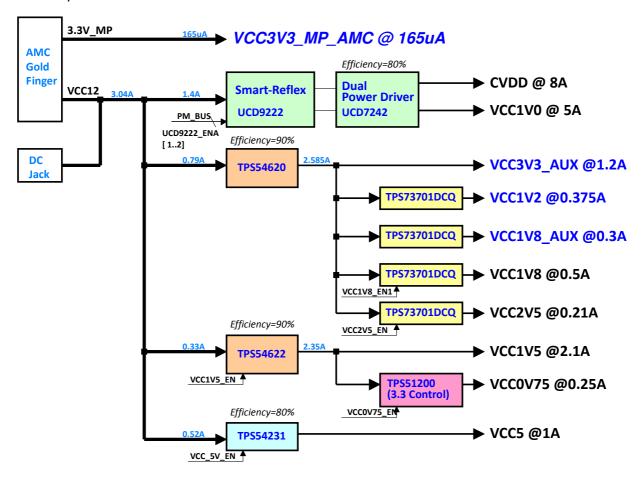


Figure 4.1: All the AMC power supply on TMDXEVM6678L EVM

Individual control for each (remaining) voltage regulator is provided to allow flexibility in how the power planes are sequenced (Refer to section 4.3 for specific details). The goal of all power supply designs is to support the ambient temperature range of 0°C to 45°C.

The TMS320C6678 core power is supplied using a dual digital controller coupled to a high performance FET driver IC. Additional DSP supply voltages are provided by discrete TI Swift power supplies. The TMS320C6678 supports a VID interface to enable Smart-Reflex® power supply control for its primary core logic supply. Refer to the TMS320C6678 Data Manual and other documentation for an explanation of the Smart-Reflex® control.

Figure 4.1 shows that the EVM power supplies are a combination of switching supplies and linear supplies. The linear supplies are used to save space for small loads. The switching supplies are implemented for larger loads. The switching supplies are listed below followed by explanations of critical component selection:

- CVDD (AVS core power for TMS320C6678)
- VCC1V0 (1.0V fixed core power for TMS320C6678)
- VCC3V3 AUX (3.3V power for peripherals)

- VCC1V5 (1.5V DDR3 power for TMS320C6678 and DDR3 memories)
- VCC5 (5.0V power for the XDS520V2 mezzanine card)

The **CVDD** and **VCC1V0** power rails are regulated by TI Smart-Reflex controller UCD9222 and the dual synchronous-buck power driver UCD7242 to supply DSP AVS core and CVDD1 core power.

The VCC3V3\_AUX and VCC1V5 power rails are regulated by two TI 6A Synchronous Step Down SWIFT™ Converters, TPS54620, to supply the peripherals and other power sources and the DSP DDR3 EMIF and DDR3 memory chips respectively.

The **VCC5** power rail is regulated by TI 2A Step Down SWIFT™ DC/DC Converter, TPS54231, to supply the power of the XDS560V2 mezzanine card on TMDXEVM6678L.

The high level diagrams and output components are shown in figure 4.2, figure 4.3, figure 4.4, and figure 4.5 as well as choosing the proper inductors and buck capacitors.

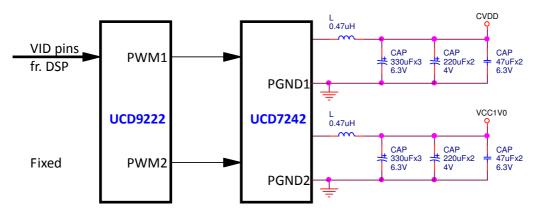
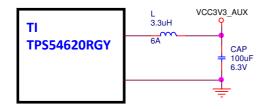


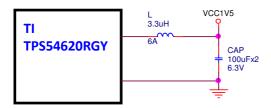
Figure 4.2: The CVDD and VCC1V0 (CVDD1) power design on TMDXEVM6678L EVM



(Over all tolerance is 5%, DC tolerance is 2.5%) (KIND=0.3)

```
 \begin{array}{lll} \textbf{Output capacitor Calculation} & \textbf{Inductor Calculation} \\ \textbf{Cout=(2*delta(lout))/(Fsw*delta(Vout))} & \textbf{L = ((Vin(max) - Vout)/lout * Kind)) * (Vout/(Vin(max) * Fsw))} \\ \textbf{Cout=(2*2.58)/(1MHz*0.0825)} & \textbf{L = ((12.6 - 3.3)/2.58 * Kind) * (3.3 / (12.7 * 1MHz))} \\ \textbf{Cout=(5.16)/(82500)} & \textbf{L = ((9.3/2.58 * 0.3) * (3.3 / (12.7M))} \\ \textbf{Cout=63uF} & \textbf{L = (9.3/0.774) * (0.26M)} \\ \textbf{Reference Capacitor=100uF} & \textbf{Reference Inductor 3.3uH} \\ \end{array}
```

Figure 4.3: The VCC3 AUX power design on TMDXEVM6678L EVM



(Over all tolerance is 5%, DC tolerance is 2.5%)

ΤI

**TPS54231D** 

22uH

B340A

2.8A

```
 \begin{array}{lll} \textbf{Output capacitor Calculation} & \textbf{Inductor Calculation} & (KIND=0.3) \\ \textbf{Cout}=(2*delta(lout))/(Fsw*delta(Vout)) & \textbf{L}=((Vin(max)-Vout)/lout*Kind))*(Vout/(Vin(max)*Fsw)) \\ \textbf{Cout}=(2*2.12)/(1MHz*0.0375) & \textbf{L}=((12.6-1.5)/2.12*Kind)*(1.5/(12.7M)) \\ \textbf{Cout}=(4.24)/(37500) & \textbf{L}=((11.1/2.12*0.3)*(1.5/(12.7M))) \\ \textbf{Cout}=113uF & \textbf{L}=(11.1/0.636)*(0.12M) \\ \textbf{Reference Capacitor}=100uF*2=200uF & \textbf{Reference Inductor 3.3uH} \\ \end{array}
```

Figure 4.4: The VCC1V5 power design on TMDXEVM6678L EVM

100uF

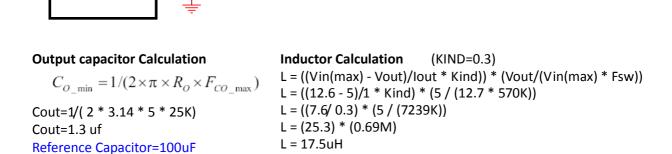


Figure 4.5: The VCC5 power design on TMDXEVM6678L EVM

Reference Inductor 22uH

### 4.3 The Power Supply Boot Sequence

Specific power supply and clock timing sequences are identified below. The TMS320C6678 DSP requires specific power up and power down sequencing. Figure 4.2 and Figure 4.3 illustrate the proper boot up and down sequence. Table 4.3 provides specific timing details for Figure 4.2.

Refer to the TMS320C6678 DSP Data Manual for confirmation of specific sequencing and timing requirements.

| Step | Power rails   | Timing | Descriptions   |
|------|---|--------|--|
|      | Power-Up  |        |  |
| 1    | VCC12 (AMC Payload power), VCC3V3_AUX, VCC1V8_AUX VCC1V2 VCC5 | Auto   | When the 12V power is supplied to the TMDXEVM6678L, the 3.3V, 1.8V and 1.2V supplies to the FPGA power will turn on. FPGA outputs to the DSP will be locked (held at ground)                                     |
| 2    | VCC5,<br>VCC2V5   | 10mS   | Turn on VCC5 and VCC2V5 after VCC3V3 stable for 10mS.  |
| 3    | CVDD (DSP AVS core power)                                     | 5mS    | Turn on CVDD, the UCD9222 power rail#1 after both of VCC5 and VCC2V5 are stable for 5mS.   |
| 4    | VCC1V0 (DSP CVDD1 fixed core power)                           | 5mS    | Turn on VCC1V0, the UCD222 power rail#2 5mS after CVDD is enabled.   |
| 5    | VCC1V8 (DSP IO power)   | 5mS    | Turn on VCC1V8 after VCC1V0 stable for 5mS.  |
| 6    | CDCE62005#2/#3 initiations<br>FPGA 1.8V outputs               | 5mS    | Unlock the 1.8V outputs and initiate the CDCE62005s after VCC1V8 stable for 5mS. De-asserted CDCE62005 power down pins (PD#), initial the CDCE62005s.  |
| 7    | VCC1V5 (DSP DDR3 power)                                       | 5mS    | Turn on VCC1V5 after initiation of the CDCE62005s for 5mS.   |
| 8    | VCC0V75   | 5mS    | Turn on VCC0V75 after VCC1V5 stable for 5mS.   |
| 9    | RESETz<br>Other reset and NMI pins                            | 5mS    | De-asserted RESETz and unlock other reset and NMI pins for the DSP after VCCOV75 stable and CDCE62005 PLLs locked for 5mS. In the meanwhile, the FPGA will driving the boot configurations to the DSP GPIO pins. |
| 10   | PORz  | 5mS    | De-asserted PORz after RESETz de-asserted for 5mS.   |

| 11 | RESETFULLz  | 5mS | De-asserted RESETFULLz after PORz de-asserted for 5mS.  |
|----|---|-----|---|
| 12 | DSP GPIO pins for boot configurations                   | 1mS | Release the DSP GPIO pins after<br>RESETFULLz de-asserted for 1mS   |
|    | Power-Down  |     |   |
| 13 | RESETFULLZ<br>PORz                                      | 0mS | If there is any power failure events or the AMC payload power off, the FPGA will assert the RESETFULLz and PORz signals to the DSP. |
| 14 | FPGA 1.8V outputs<br>CDCE62005 PD# pins                 | 5mS | Locked 1.8V output pins on the FPGA and pull the CDCE62005 PD# pins to low to disable DSP clocks.                                   |
| 15 | CVDD<br>VCC1V0<br>VCC1V8<br>VCC1V5<br>VCC0V75<br>VCC2V5 | 0mS | Turn off all main power rails.  |

Table 4.3: The power-up and down timing on the TMDXEVM6678L

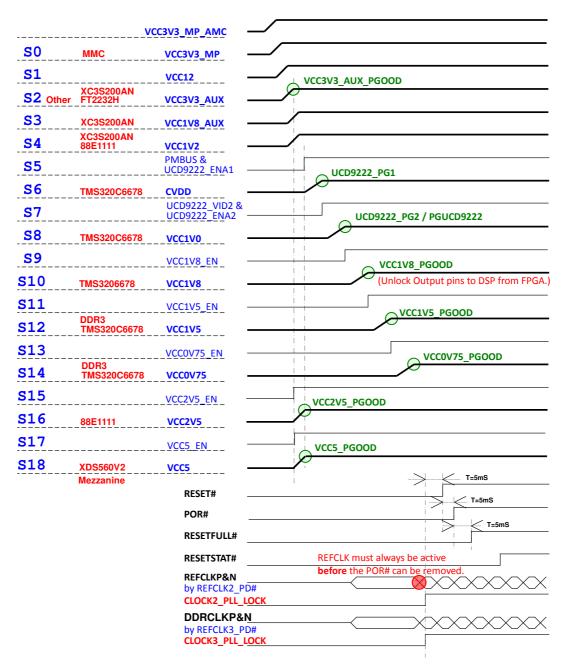


Figure 4.6: Initial Power Up Sequence Timing Diagram

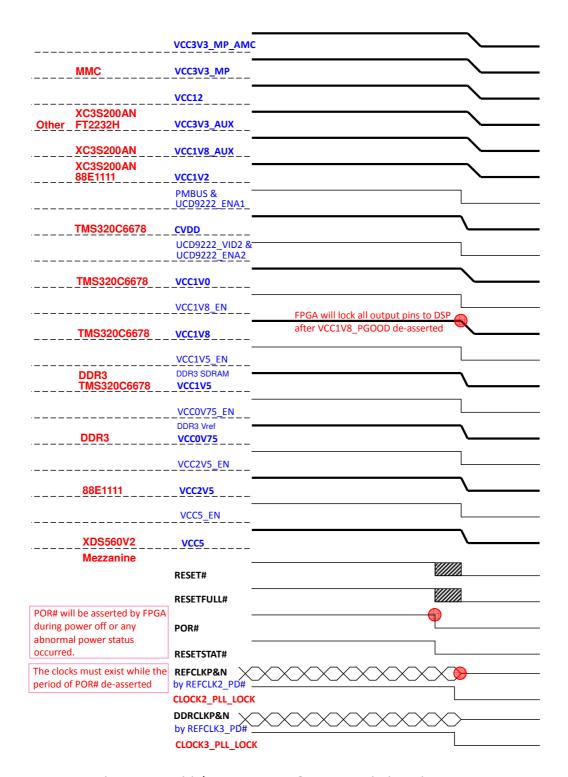


Figure 4.7: Initial Power Down Sequence Timing Diagram

#### 5. TMDXEVM6678L FPGA FUNCTIONAL DESCRIPTION

This chapter contains,

- 5.1 FPGA overview
- 5.2 FPGA signals description
- 5.3 Sequence of operation
- 5.4 Reset definition
- 5.5 SPI protocol
- 5.6 CDCE62005 Programming Descriptions
- 5.7 FPGA Configuration Registers

#### 5.1 FPGA overview

The FPGA (Xilinx XC3S200AN) controls the EVM power sequencing, reset mechanism, DSP boot mode configuration and clock initialization. The FPGA also provides the transformation of TDM Frame Synchronization signal and Reference Clock between the AMC connector and the DSP.

The FPGA also supports 4 user LEDs and 1 user switch through control registers. All the FPGA registers are accessible by the TMS320C6678 DSP.

The key features of the TMDXEVM6678L EVM FPGA are:

- TMDXEVM6678L EVM Power Sequence Control
- TMDXEVM6678L EVM Reset Mechanism Control
- TMDXEVM6678L EVM Clock Generator Initialization and Control
- TMS320C6678 DSP SPI Interface for Accessing the FPGA Configurable Registers
- Provides Shadow Registers for TMS320C6678 DSP to Access the Clock Generator Configurations Registers
- Provides Shadow Registers for TMS320C6678 DSP to Access the UCD9222 Devices via the PM Bus (RFU)
- Provides TMS320C6678 DSP Boot Mode Configuration switch settings to DSP
- MMC Reset Events Initiation Interface
- Provides the transformation of TDM Frame Synchronization and Reference Clock between AMC and DSP

- Provide Ethernet PHY Interrupt(RFU) and Reset Control Interface
- Provides support for Reset Buttons, User Switches and Debug LEDs

# 5.2 FPGA signals description

This section provides a detailed description of each signal. The signals are arranged in functional groups according to their associated interface. Throughout this manual, a '#' or 'Z' will be used at the end of a signal name to indicate that the active or asserted state occurs when the signal is at a low voltage level.

The following notations are used to describe the signal and type.

| 1            | Input pin              |
|--------------|------------------------|
| 0            | Output pin             |
| I/O          | Bi-directional pin     |
| Differential | Differential Pair pins |
| PU           | Internal Pull-Up       |

Table 5.1: TMDXEVM6678L EVM FPGA Pin Description

| Pin Name        | Ю Туре | Description                                      |  |
|-----------------|--------|--|--|
| MMC Control:    |        |  |  |
| MMC_DETECT#     | 1      | MMC Detection on the insertion to an AMC         |  |
|                 | PU     | Chassis: This signal is an insertion indication  |  |
|                 |        | from the MMC. The MMC will drive logic low       |  |
|                 |        | state when the EVM module is inserted into an    |  |
|                 |        | AMC chassis.                                     |  |
| MMC_RESETSTAT#  | 0      | RESETSTAT# state to MMC: The FPGA will           |  |
|                 |        | drive the same status of the DSP RESETSTAT# to   |  |
|                 |        | the MMC via this signal.                         |  |
| MMC_POR_IN_AMC# | I      | MMC POR Request: This signal is used by the      |  |
|                 | PU     | MMC to request a power-on reset sequence to      |  |
|                 |        | DSP. A logic Low to High transition on this      |  |
|                 |        | signal will complete the FPGA Full Reset         |  |
|                 |        | sequence with a specified delay time.            |  |
| MMC_WR_AMC#     | I      | MMC WARM Request: This signal is used by         |  |
|                 | PU     | the MMC to initiate a warm reset request. A      |  |
|                 |        | logic Low to High transition on this signal will |  |
|                 |        | complete the FPGA warm reset sequence with       |  |
|                 |        | a specified delay time.                          |  |

| Pin Name                     | Ю Туре                    | Description  |  |  |  |
|------------------------------|---------------------------|--|--|--|--|
| MMC_BOOTCOMPLET              | 0                         | <b>BOOTCOMPLETE state to MMC</b> : The FPGA will   |  |  |  |
| E                            |                           | drive the same status of the DSP                   |  |  |  |
|                              |                           | BOOTCOMPLETE to the MMC via this signal.           |  |  |  |
| <b>Power Sequences Cont</b>  | Power Sequences Control : |  |  |  |  |
| VCC5_PGOOD                   | 1                         | 5V Voltage Power Good Indication: This signal      |  |  |  |
|                              |                           | indicates the 5V power is valid.                   |  |  |  |
| VCC2P5_PGOOD                 | 1                         | 2.5V Voltage Power Good Indication : This          |  |  |  |
|                              |                           | signal indicates the 2.5V power is valid.          |  |  |  |
| VCC3_AUX_PGOOD               | 1                         | 3.3V Auxiliary Voltage Power Good                  |  |  |  |
|                              |                           | Indication: This signal indicates the 3.3V         |  |  |  |
|                              |                           | auxiliary power is valid.                          |  |  |  |
| VCC0P75_PGOOD                | 1                         | 0.75V Voltage Power Good Indication: This          |  |  |  |
|                              |                           | signal indicates the 0.75V power is valid.         |  |  |  |
| VCC1P5_PGOOD                 | 1                         | 1.5V Voltage Power Good Indication : This          |  |  |  |
|                              |                           | signal indicates the 1.5V power is valid.          |  |  |  |
| VCC1P8_PGOOD                 | 1                         | 1.8V Voltage Power Good Indication : This          |  |  |  |
|                              |                           | signal indicates the 1.8V power is valid.          |  |  |  |
| SYS_PGOOD                    | 0                         | System Power Good Indication: This signal is       |  |  |  |
|                              |                           | indicated by the FPGA to the system when all       |  |  |  |
|                              |                           | the power supplies are valid.                      |  |  |  |
| VCC1P8_EN1                   | 0                         | 1.8V Voltage Power Supply Enable :                 |  |  |  |
|                              |                           | VCC1P8_EN1 is for 1.8V power plane control.        |  |  |  |
| VCC0P75_EN                   | 0                         | 0.75V Voltage Power Supply Enable :                |  |  |  |
|                              |                           | VCC0P75_EN is for 0.75V power plane control.       |  |  |  |
| VCC2P5_EN                    | 0                         | 2.5V Voltage Power Supply Enable :                 |  |  |  |
|                              |                           | VCC2P5_EN is for 2.5V power plane control.         |  |  |  |
| VCC_5V_EN                    | 0                         | <b>5V Voltage Power Supply Enable :</b> VCC_5V_EN  |  |  |  |
|                              |                           | is for 5V power plane control.                     |  |  |  |
| <b>CLOCK Configurations:</b> |                           |  |  |  |  |
| CLOCK[2:3]_SSPCS1            | 0                         | SPI Chip Select Enable: This signal is             |  |  |  |
|                              |                           | connected to the TI CDCE62005 CLOCK                |  |  |  |
|                              |                           | Generators SPI_LE pin. The falling edge of the     |  |  |  |
|                              |                           | SSPCS1 initiates a transfer. If SSPCS1 is high, no |  |  |  |
|                              |                           | data transfer can take place.                      |  |  |  |
| CLOCK[2:3]_SSPCK             | 0                         | SPI Serial Clock: This signal is connected to the  |  |  |  |
|                              |                           | TI CDCE62005 CLOCK Generators SPI_CLK pin.         |  |  |  |
|                              |                           | The FPGA SPI bus clocks data in and out on the     |  |  |  |
|                              |                           | rising edge of SSPCK. Data transitions therefore   |  |  |  |
|                              |                           | occur on the falling edge of the clock.            |  |  |  |
| CLOCK[2:3]_SSPSI             | 0                         | SPI Serial Data MOSI: This signal is connected     |  |  |  |
|                              |                           | to the TI CDCE62005 CLOCK Generators MOSI          |  |  |  |
|                              |                           | pin. This signal is used for serial data           |  |  |  |
|                              |                           | transfers from the master (FPGA) output to the     |  |  |  |
|                              |                           | slave (CDCE62005) input.                           |  |  |  |

| Pin Name            | IO Type  | Description   |
|---------------------|----------|---|
| CLOCK[2:3]_SSPSO    | I        | SPI Serial Data MISO: This signal is connected          |
|                     | PU       | to the TI CDCE62005 CLOCK Generators MISO               |
|                     |          | pin. This signal is used for the serial data            |
|                     |          | transfers from the slave (CDCE62005) output to          |
|                     |          | the master (FPGA) input.                                |
| REFCLK[2:3]_PD#     | 0        | TI CDCE62005 CLOCK Generator Power Down:                |
|                     |          | The power down pins each place the respective           |
|                     |          | CDCE62005 into the power down state forcing             |
|                     |          | the differential clock output into the                  |
|                     | <u> </u> | high-impedance state.                                   |
| UCD9222 Interface : | _        |   |
| UCD9222_PG1         | I        | UCD9222 Power Good Indication for CVDD                  |
|                     |          | <b>DSP Core Power :</b> This signal indicates the       |
|                     |          | CVDD DSP core power is valid.                           |
| UCD9222_ENA1        | 0        | UCD9222 Enable for CVDD DSP Core Power :                |
|                     |          | UCD9222_ENA1 is for CVDD DSP core power                 |
|                     |          | plane control.  |
| UCD9222_PG2         | 1        | UCD9222 Power Good Indication for VCC1V0                |
|                     |          | <b>DSP Core Power :</b> This signal indicates the       |
|                     |          | VCC1V0 DSP core power is valid.                         |
| UCD9222_ENA2        | 0        | UCD9222 Enable for VCC1V0 DSP Core Power :              |
|                     |          | UCD9222_ENA2 is for VCC1V0 DSP core power               |
|                     |          | plane control.  |
| PGUCD9222           | I        | UCD9222 Power Good Indication : This signal             |
|                     |          | indicates both the CVDD DSP and VCC1V0 DSP              |
|                     |          | core power supplies are valid.                          |
| UCD9222_RST#        | 0        | UCD9222 Reset: An active low signal will reset          |
|                     |          | the UCD9222 device.                                     |
| PM BUS : (RFU)      | 1        |   |
| PMBUS_CLK           | 0        | PM Bus Clock : The FPGA provides the clock              |
|                     |          | source on the PM bus.                                   |
| PMBUS_DAT           | 1/0      | PM Bus Data : A PM Bus slave device can                 |
|                     |          | receive data provided by the master (FPGA), or          |
|                     |          | it can also provide data to the master (FPGA)           |
|                     |          | via this signal line.                                   |
| PMBUS_ALT           | I        | PM Bus Alert: The PM Bus device may notify              |
|                     |          | the host (FPGA) via this signal if a fault or           |
|                     |          | warning is detected.                                    |
| PMBUS_CTL           | 1        | <b>PM Bus Control :</b> This signal is used to turn the |
|                     | PU       | device on and off in conjunction with                   |
|                     |          | UCD9222_ENA1 / UCD9222_ENA2 pins.                       |
| PHY Interface :     | _        |   |
| PHY_INT#            | 1        | Interrupt Request from 88E111 PHY (RFU)                 |

| Pin Name                     | ІО Туре    | Description   |  |  |
|------------------------------|------------|---|--|--|
| PHY_RST#                     | 0          | Reset to 88E1111 PHY: This signal is used to reset the 88E1111 PHY device. The PHY_RST# will be asserted during the active DSP_PORZ or DSP_RESETFULLZ period. The PHY_RST# logic also can be configured by the DSP accessed register. |  |  |
| DSP SPI:                     |            |   |  |  |
| DSP_SSPCS1                   | I          | DSP SPI Chip Select 1: This signal is connected to the TMS320C6678 DSP SPISCS1 pin. The falling edge of the SSPCS1 from the DSP will initiate a transfer. If SSPCS1 is high, no data transfer can take place.                         |  |  |
| DSP_SSPCK                    | I          | DSP SPI Serial Clock: This signal is connected to the TMS320C6678 DSP SPICLK pin. The FPGA SPI bus clocks data in on the falling edge of SSPCK. Data transitions therefore occur on the rising edge of the clock.                     |  |  |
| DSP_SSPMISO                  | 0          | DSP SPI Serial Data MISO: This signal is connected to the TMS320C6678 DSP SPIDIN pin. This signal is used for serial data transfers from the slave (FPGA) output to the master (DSP) input in the DSP_SSPCS1 asserted period.         |  |  |
| DSP_SSPMOSI                  | I          | DSP SPI Serial Data MOSI: This signal is connected to the DSP SPIDOUT pin. This signal is used for serial data transfers from the master (DSP) output to the slave (FPGA) input.  |  |  |
| RESET Buttons and Requests : |            |   |  |  |
| FULL_RESET                   | I          | Full Reset Button Input: This button input is used to initiate a Full Reset event.  |  |  |
| WARM_RESET                   | 1          | Warm Reset Button Input: This button input is used to initiate a Warm Reset event.  |  |  |
| COLD_RESET<br>(RFU)          | 1          | Cold Reset Button Input: Reserved for Future Use (RFU).   |  |  |
| FPGA_JTAG_RST#<br>(RFU)      | 1          | FPGA JTAG Reset Input :<br>Reserved for Future Use (RFU).   |  |  |
| TRGRSTZ                      | I          | Reset Request from the DSP Emulator Header: A warm Reset sequence will be initiated if an active TRGRSTZ event is recognized by the FPGA.   |  |  |
| DSP Boot & Device con        | figuration | T   |  |  |
| BM_GPIO[0 : 15]              | I          | <b>DSP Boot Mode Strap Configurations :</b> These switch inputs are used to drive the DSP boot mode configuration during the EVM power up period.   |  |  |

| Pin Name               | ІО Туре | Description  |  |
|------------------------|---------|--|--|
| DSP_GPIO[0 : 15]       | 1/0     | <b>DSP GPIO</b> : In normal operation mode, these  |  |
|                        |         | signals are not driven by the FPGA so that the     |  |
|                        |         | DSP can use them as GPIO pins. During the          |  |
|                        |         | EVM power-on or during the RESETFULLz              |  |
|                        |         | asserted period, the FPGA will output the          |  |
|                        |         | BM_GPIO switch values to the DSP on these          |  |
|                        |         | pins so the DSP can latch the boot mode            |  |
|                        |         | configuration.                                     |  |
| DSP RESET & Interrupts | 1       |  |  |
| DSP_CORESEL[0:3]       | 0       | DSP Core Selection Bit:                            |  |
|                        |         | The default value is 0000b and Register bits       |  |
|                        |         | define the state of these pins.                    |  |
| DSP_PACLKSEL           | 0       | <b>DSP PACLKSEL</b> : This pin is used for the DSP |  |
|                        |         | PASS clock selection setting. The logic of this    |  |
|                        |         | signal is derived from the BM_GPIO[13:11]          |  |
|                        |         | state or configured by the FPGA registors.         |  |
| DSP_LRESETNMIENZ       | 0       | Latch Enable for DSP Local Reset and NMI           |  |
|                        |         | inputs :The default value is 1b and a register     |  |
|                        |         | bit defines the state of this pin.                 |  |
| DSP_NMIZ               | 0       | DSP NMI.   |  |
|                        |         | The default value is 1b and unlocked a register    |  |
|                        |         | bit defines the state of this pin.                 |  |
| DSP_LRESETZ            | 0       | DSP Local Reset.                                   |  |
|                        |         | The default value is 1b and a register bit         |  |
|                        |         | defines the state of this pin.                     |  |
| DSP_HOUT               | 1       | DSP HOUT   |  |
| DSP_BOOTCOMPLETE       | I       | DSP Boot Complete Indication                       |  |
| DSP_SYSCLKOUT          | 1       | DSP System Clock Output                            |  |
| DSP_PORZ               | 0       | DSP Power-On Reset                                 |  |
| DSP_RESETFULLZ         | 0       | DSP Full Reset.                                    |  |
| DSP_RESETZ             | 0       | DSP Reset  |  |
| FPGA Storage (RFU):    |         |  |  |
| FPGA_SPI_CS#           | 0       | FPGA SPI Chip Select : (RFU)                       |  |
| FPGA_SPI_SI            | 0       | FPGA SPI Serial Data MOSI : (RFU)                  |  |
| FPGA_SPI_SCK           | 0       | FPGA SPI Clock Output : (RFU)                      |  |
| FPGA_SPI_SO            | 1       | FPGA SPI Serial Data MISO : (RFU)                  |  |
| DSP TDM CLK:           |         |  |  |
| DSP_TSIP0_FS[A:B]0     | 0       | DSP TSIP0_FS[A:B]0 : The single-ended clock        |  |
|                        |         | (DSP_TSIP0_FSA0 and DSP_TSIP0_FSB0)                |  |
|                        |         | outputs are derived from the differential TDM      |  |
|                        |         | Frame Synchronization (TDM_CLKC) input.            |  |

| Pin Name            | IO Type      | Description  |  |
|---------------------|--------------|--|--|
| DSP_TSIP1_FS[A:B]1  | 0            | DSP TSIP1_FS[A:B]1 : The single-ended clock  |  |
|                     |              | (DSP_TSIP1_FSA1 and DSP_TSIP1_FSB1)  |  |
|                     |              | outputs are derived from the differential TDM  |  |
|                     |              | Frame Synchronization (TDM_CLKC) input.  |  |
| DSP_TSIP0_CLK[A:B]0 | 0            | DSP TSIP0_CLK[A:B]0 : The single-ended clock   |  |
|                     |              | (DSP_TSIP0_CLKA0 and DSP_TSIP0_CLKB0)  |  |
|                     |              | outputs are derived from the differential TDM  |  |
|                     |              | clock (TDM_CLKA) input.  |  |
| DSP_TSIP1_CLK[A:B]1 | 0            | <b>DSP TSIP1_CLK[A:B]1 :</b> The single-ended clock  |  |
|                     |              | (DSP_TSIP1_CLKA1 and DSP_TSIP1_CLKB1)  |  |
|                     |              | outputs are derived from the differential TDM  |  |
|                     |              | clock (TDM_CLKA) input.  |  |
| TDM_CLKA[p/n]       | I, Diff      | TDM_CLKA Different Clock Input Pairs   |  |
|                     |              | The reference clock referring to the TSIP0/1   |  |
|                     |              | CLKs of the DSP.   |  |
| TDM_CLKB[p/n]       | I, Diff      | TDM_CLKB Different Clock Input Pairs   |  |
| (RFU)               |              | Reserved for future use (RFU).   |  |
| TDM_CLKC[p/n]       | I, Diff      | TDM_CLKC Different Clock Input Pairs   |  |
|                     |              | The frame synchronization signal referring to  |  |
|                     |              | the TSIPO/1 FSs of the DSP.  |  |
| TDM_CLKD[p/n]       | I, Diff      | TDM_CLKD Different Clock Input Pairs   |  |
| (RFU)               |              | Reserved for future use (RFU)  |  |
| DEBUG LED:          | <del>-</del> |  |  |
| DEBUG_LED[1:4]      | 0            | <b>Debug LED</b> : The LEDs are used for debugging   |  |
|                     |              | purposes only. It can be configured by the   |  |
|                     |              | registers in the FPGA.   |  |
| Miscellaneous:      |              |  |  |
| MAIN_48MHZ_CLK_R    | 1            | FPGA Main Clock Source : A 48 MHz clock is   |  |
|                     |              | used as the FPGA main clock source.  |  |
| DSP_TIMI0           | 0            | <b>DSP Timer 0 Clock</b> : The FPGA provides a   |  |
|                     |              | 24MHz clock to the DSP timer 0 input. During   |  |
|                     |              | the EVM Power-on or RESETFULLZ asserted  |  |
|                     |              | period, the FPGA will drive the PCIESSEN   |  |
|                     |              | switch state to DSP for latching.  |  |
| DSP_VCL_1 (RFU)     | 1            | DSP Smart Reflex I2C Clock   |  |
| DSP_VD_1 (RFU)      | 1/0          | DSP Smart Reflex I2C Clock   |  |
| PCA9306_EN          | 0            | PCA9306 Enable: This signal is used to enable  |  |
|                     |              | the DSP Smart Reflex I2C buffer function.  |  |
| NAND WP#            | 0            | NAND Flash Write Protect : This signal is used   |  |
| _                   |              | to control the NAND flash write-protect  |  |
|                     |              | function.  |  |
| NOR WP#             | 0            | NOR Flash Write Protect : This signal is used to   |  |
| _                   |              | control the NOR flash write-protect function.  |  |
| EEPROM WP           | 0            | <b>EEPROM Write Protect :</b> This signal is used to   |  |
|                     |              | control the EEPROM write-protect function.   |  |
| ĺ                   |              | The state of the s |  |

| Pin Name                    | IO Type | Description   |  |
|-----------------------------|---------|---|--|
| PCIESSEN                    | I       | PCIE Subsystem Enable: This is used for the           |  |
|                             |         | PCIESSEN switch input.                                |  |
| USER_DEFINE                 | 1       | <b>User Defined Switch</b> : This is reserved for the |  |
|                             |         | user defined switch input.                            |  |
| XDS560_IL                   | 0       | XDS560 IL: XDS560 IL control signal                   |  |
| FPGA JTAG TAP Control Port: |         |   |  |
| JTAG_FPGA_TCK               | 1       | FPGA JTAG Clock Input                                 |  |
| JTAG_FPGA_TDI               | 1       | FPGA JTAG Data Input                                  |  |
| JTAG_FPGA_TDO               | 0       | FPGA JTAG Data Output                                 |  |
| JTAG_FPGA_TMS               | 1       | FPGA JTAG Mode Select Input                           |  |
| JTAG_FPGA_RST#              | 1       | FPGA JTAG Reset (RFU)                                 |  |

# 5.3 Sequence of operation

This section describes the FPGA sequence of operation on the EVM. It contains:

- 5.3.1 Power-On Sequence
- 5.3.2 Power Off Sequence
- 5.3.3 Boot Configuration Timing
- 5.3.4 Boot Configuration Forced in I2C Boot
- 5.3.1 Power-On Sequence

The following section provides details of the FPGA Power-On sequence of operation.

- 1. After the EVM 3.3V auxiliary voltage (VCC3V3\_AUX\_PGOOD) is valid and stable, and the FPGA design code is loaded, the FPGA is ready for the Power-On sequence of operation.
- 2. The FPGA starts to execute the Power-On sequence. Wait for 10 ms, the FPGA enable the 2.5V power.
- 3. Once the 2.5V voltages (VCC5\_PGOOD and VCC2V5\_PGOOD) is valid, wait for 5 ms, the FPGA asserts the UCD9222\_ENA1 to enable the CVDD DSP core power.
- 4. After the UCD9222\_ENA1 enabled for 5 ms, the FPGA asserts the UCD9222\_ENA2 to enable the VCC1V0 DSP core power.
- 5. After both the UCD9222\_PG1, UCD9222\_PG2 and PGUCD9222 are all valid, wait for 5 ms, the FPGA enables the 1.8V power.
- 6. After the 1.8V voltage is valid (VCC1V8 PGOOD asserted), wait for 5 ms and then:
  - Unlock the 1.8V outputs on the FPGA,

- De-asserted CDCE62005#2\_PD# pin, after driving CDCE62005\_PD# to high for 1mS, the FPGA starts to initialize the CDCE62005 clock generator #2.
- During the initiation phase of the CDCE62005#2, the FPGA de-asserts the CDCE62005#3\_PD# pin and checks the CDCE62005#2 PLL\_LOCK state. Once the PLL\_Lock state is valid, the FPGA starts to initialize CDCE62005 clock generator #3.
- 7. After finishing the initiation of the CDCE62005#3, wait for 5mS, the FPGA enables the 1.5V power rail.
- 8. After the 1.5V voltage is valid (VCC1V5\_PGOOD), wait for 5 ms, the FPGA enables the 0.75V power.
- 9. After the 0.75V voltage is valid (VCCOV75\_PGOOD asserted), wait for 5ms and check the both of the CDCE62005 PLL\_LOCK states, after the PLL states of the CDCD62005s are valid, the FPGA de-asserts the DSP\_RESETz and DSP\_LRESETz and Keep the DSP PORz and DSP\_RESETFULLz in assertion.
- 10. After the DSP\_RESETz and DSP\_LRESETz have de-asserted, wait for 5 ms, the FPGA de-asserts the DSP\_PORz and keeps the DSP\_RESETFULLz still being asserted. Wait for another 5 ms, the FPGA de-asserts the DSP\_RESETFULLz. The FPGA will drive the BM\_GPIO switches value to the DSP for the DSP boot mode configuration strapping during the period from the VCCOP75\_PGOOD is valid to the RESETSTAT# being de-asserted. The FPGA will also drive the PCIESSEN switch value to DSP\_TIMIO for the DSP boot configuration strapping.
- 11. Wait for the RESETSTAT# signal from DSP to go from low to high. The EVM Power-On sequence is completed.

#### 5.3.2 Power Off Sequence

Following section provides details of FPGA power off sequence of operation.

- 1. Once the system powers on, any power failure events (any one of power good signals de-asserted) will trigger the FPGA to proceed to the power off sequence.
- 2. Once any de-asserted Power Good signals have been detected by the FPGA, the FPGA will assert the DSP\_PORz and DSP\_RESETFULLz to DSP immediately.
- 3. Wait for 5 ms, the FPGA will disable all the system power rails by the enable pins and two CDCE62005 clock generators by the power down pins, assert all the other DSP resets to DSP, lock the +1.8V output pins from the FPGA to the DSP.
- 4. FPGA remains in the power failure state until main 12V power is removed and restored.

#### 5.3.3 Boot Configuration Timing

The boot configuration timing of the power-up and the RESETFULLz event are shown below.

PORZ

Both 62005s are locked

S ms delay

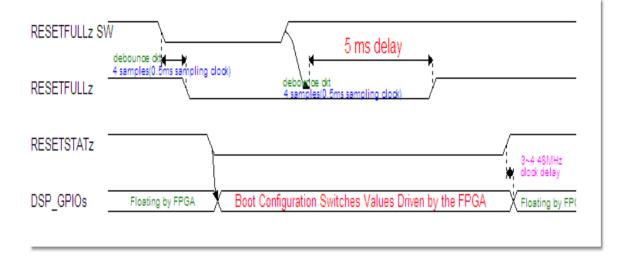
5 ms delay

Floating by FPGA

Floating by FPGA

Figure 5-1 Power-On Reset Boot Configuration Timing

Figure 5-2 Reset-Full Switch/Trigger Boot Configuration Timing



#### 5.3.4 Boot Configuration Forced in I2C Boot

Note: This workaround is only needed with PG1.0 samples of the TMS320C6678 DSP.

For reliable PLL operation at boot-up, the FPGA will force the DSP to boot from the I2C by providing the boot configuration value as 0x0405 on the boot mode pins [12:0]. After the code in the I2C SEEPROM executes to initialize the PLLs, it will read the true values on the DIP switches from the registers in the FPGA and then boot as if the normal boot sequence had occurred.

The exception for the forced I2C boot is the emulation boot. The FPGA will not perform the I2C boot configuration override when the DIP switches have the following configuration: BOOTMODE[2:0] (GPIO[3:1]) = [000] and BOOTMODE[5:4] (GPIO[6:5]) = [00].

Therefore, the additional logic of the FPGA will allow the emulation boot to latch directly from the DIP switches.

#### 5.4 Reset definition

#### 5.4.1 Reset Behavior

- Power-On: The Power-On behavior includes initiating and sequencing the power sources, clock sources and then DSP startup. Please refer to the section 5.5.1 for detailed sequence and operations.
- **Full Reset**: The RESETFULLz is asserted low to the DSP. This causes RESETSTAT# to go low which triggers the boot configuration to be driven from the FPGA. Reset to the Marvell PHY is also asserted. POR# and RESET# to the DSP remain high. The power supplies and clocks operate without interruption. Please refer to the section 5.5.3 for detailed timing diagrams.
- Warm Reset: The RESETz is asserted low to the DSP. The PORz and RESETFULLz to the DSP remain high. The power supplies and clocks operate without interruption.

### 5.4.2 Reset Switches and Triggers

• **FULL\_RESET** (RST\_FULL1) – a logic low state with a low to high transition will trigger a Full Reset behavior event.

When the push button switch RST\_FULL1 is pressed, FPGA on EVM will assert DSP's RESETFULL# input to issue a total reset of the DSP, everything on the DSP will be reset to its default state in response to this event, boot configurations will be latched and the ROM boot process will be initiated.

This is equivalent to a power cycle of the board but POR and will have following effects:

- \* Reset DSP
- \* Reset Gigabit Ethernet PHY
- \* Reload boot parameters.
- \* Protect the conents in the I2C EEPROM, NAND flash and SPI NOR flash.
- WARM\_RESET (RST\_WARM1) a logic low state with a low to high transition will trigger a warm reset behavior event.

When the push button Switch RST\_WARM1 is pressed, FPGA will assert a DSP RESET# input, which will reset the DSP. Software can program this to be either hard or soft. Hard reset is the default which resets almost everything. Soft Reset will behave like Hard Reset except that PCIe MMRs, EMIF16 MMRs, DDR3 EMIF MMRs, and External Memory contents are retained.

Boot configurations are not latched by Warm Reset. Also, Warm Reset will not reset

blocks supporting Reset Isolation when they are appropriately configured previously by application software. Warm Reset must be used to wake from low-power sleep and hibernation modes.

In the case of a Soft Reset, the clock logic or the power control logic of the peripherals are not affected, and, therefore, the enabled/disabled state of the peripherals is not affected. The following external memory contents are maintained

#### During a Soft Reset:

- **DDR3 MMRs**: The DDR3 Memory Controller registers are *not* reset. In addition, the DDR3 SDRAM memory content is retained if the user places the DDR3 SDRAM in self-refresh mode before invoking the soft reset.
- **PCIe MMRs**: The contents of the memory connected to the EMIFA are retained. The EMIFA registers are *not* reset.
- COLD\_RESET (RST\_COLD1) not used in current implementation.
- MMC\_POR\_IN\_AMC# a logic low state with a low to high transition will trigger a
  Full Reset behavior event.
- MMC\_WR\_AMC# a logic low state with a low to high transition will trigger a warm reset behavior event.
- **TRGRSTz** a logic low state with a low to high transition on the Target Reset signal from emulation header that will trigger a warm reset behavior event.
- FPGA JTAG RST# not used in current implementation.

### 5.5 SPI protocol

This section describes the FPGA SPI bus protocol design specification for interfacing with TMS320C6678 DSP and CDCE62005 clock generators. It contains:

- 5.5.1 FPGA-DSP SPI Protocol
- 5.5.2 FPGA-CEDC62005(Clock Generator) SPI Protocol

#### 5.5.1 FPGA-DSP SPI Protocol

The FPGA supports the simple write and read commands for the TMS320C6678 DSP to access the FPGA configuration registers through the SPI interface. The FPGA SPI bus clocks data in on the falling edge of DSP SPI Clock. Data transitions therefore occur on the rising edge of the clock.

The figures below illustrates a DSP to FPGA SPI write operation.

Figure 5-3; The SPI access form the TMS320C6678 to the FPGA (WRITE / high level)

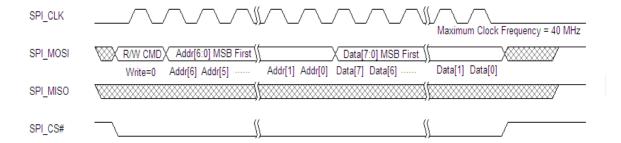
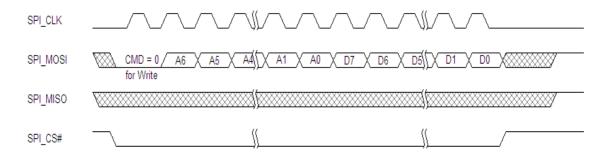


Figure 5-4: The SPI access form the TMS320C6678 to the FPGA (WRITE)



The figures below illustrates a DSP to FPGA SPI read operation.

Figure 5-5: The SPI access form the TMS320C6678 to the FPGA (READ / high level)

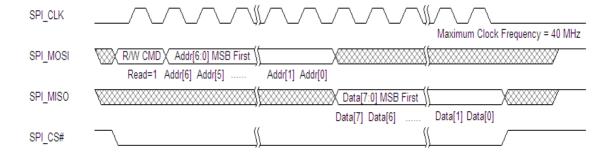
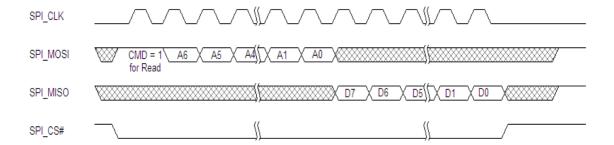


Figure 5-6: The SPI access form the TMS320C6678 to the FPGA (READ)

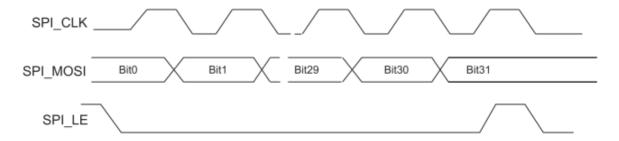


#### 5.5.2 FPGA- CDCE62005(Clock Generator) SPI Protocol

The FPGA-Clock Generator SPI interface protocol is compatible to CDCE62005 SPI. The FPGA SPI bus clocks data in on the rising edge of DSP SPI Clock. Data transitions therefore occur on the falling edge of the clock.

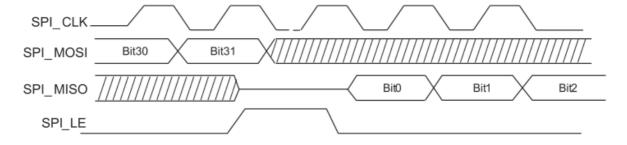
The figure below illustrates a FPGA to CDCD62005 SPI write operation.

Figure 5-7: The SPI access form the FPGA to the CDCE62005 (WRITE)



The figure below illustrates a FPGA to CDCD62005 SPI read operation.

Figure 5-8: The SPI access form the FPGA to the CDCE62005 (READ)



# **5.6 FPGA Configuration Registers**

The TMS320C6678 DSP communicates with the FPGA configuration registers through the SPI interface. These registers are addressed by memory mapped location and defined by the DSP SPI chip enable setting. The following tables list the FPGA configuration registers and the respective descriptions.

Table 5.2 : TMS320C6678 EVM FPGA Memory Map

| Memory Map Base Address       | Memory Map Offset Address | Memory                  |
|-------------------------------|---------------------------|-------------------------|
| DSP SPI Chip Select 1         | 0x00-0x3F                 | Configuration Registers |
| <b>0x20BF0000</b> -0x20BF03FF |                           |                         |
| (TMS320C6678 DSP SPI          |                           |                         |
| Memory Map Address)           |                           |                         |

# 5.6.1 FPGA Configuration Registers Summary

Table 5.3: FPGA Configuration Registers Summary

| Address Offset | Definition                                       | Attribute (R/W)<br>(RO : Read-Only) | Default Value |
|----------------|--|-------------------------------------|---------------|
| 00h            | FPGA Device ID (Low Byte)                        | RO                                  | 04h           |
| 01h            | FPGA Device ID (High Byte)                       | RO                                  | 80h           |
| 02h            | FPGA Revision ID (Low Byte)                      | RO                                  | **            |
| 03h            | FPGA Revision ID (High Byte)                     | RO                                  | 00h*          |
| 04h            | BM GPI Status (Low Byte)                         | RO                                  |               |
| 05h            | BM GPI Status (High Byte)                        | RO                                  |               |
| 06h            | DSP GPI Status (Low Byte)                        | RO                                  |               |
| 07h            | DSP GPI status (High Byte)                       | RO                                  |               |
| 08h            | Debug LED  | R/W                                 | 00h           |
| 09h            | MMC Control                                      | RO                                  |               |
| 0Ah            | PHY Control                                      | R/W                                 | 03h           |
| 0Bh            | Reset Buttons Status                             | RO                                  | 00h           |
| 0Ch            | Miscellaneous - 1                                | R/W                                 | 1Ch           |
| 0Dh            | Miscellaneous - 2                                | RO                                  |               |
| 0Eh            | FPGA FW Update SPI Interface<br>Control Register | R/W                                 | 00h           |
| 0Fh            | Scratch Register                                 | R/W                                 | 00h           |
| 10h            | CLK-GEN 2 Control Register                       | R/W                                 | 00h           |
| 11h            | CLK-GEN 2 Interface Clock<br>Setting             | R/W                                 | 03h           |
| 13h~12h        | Reserved   |                                     | 0s            |
| 14h            | CLK-GEN 2 Command Byte 0                         | R/W                                 | 00h           |
| 15h            | CLK-GEN 2 Command Byte 1                         | R/W                                 | 00h           |
| 16h            | CLK-GEN 2 Command Byte 2                         | R/W                                 | 00h           |
| 17h            | CLK-GEN 2 Command Byte 3                         | R/W                                 | 00h           |
| 18h            | CLK-GEN 2 Read Data Byte 0                       | RO                                  | 00h           |
| 19h            | CLK-GEN 2 Read Data Byte 1                       | RO                                  | 00h           |
| 1Ah            | CLK-GEN 2 Read Data Byte 2                       | RO                                  | 00h           |
| 1Bh            | CLK-GEN 2 Read Data Byte 3                       | RO                                  | 00h           |
| 1Fh~1Ch        | Reserved   |                                     | 0s            |
| 20h            | CLK-GEN 3 Control Register                       | R/W                                 | 00h           |

| Address Offset  | Definition                 | Attribute (R/W)<br>(RO : Read-Only) | Default Value |
|---|----------------------------|-------------------------------------|---------------|
| 21h   | CLK-GEN 3 Interface Clock  | R/W                                 | 03h           |
|   | Setting                    |                                     |               |
| 23h~22h   | Reserved                   |                                     | 0s            |
| 24h   | CLK-GEN 3 Command Byte 0   | R/W                                 | 00h           |
| 25h   | CLK-GEN 3 Command Byte 1   | R/W                                 | 00h           |
| 26h   | CLK-GEN 3 Command Byte 2   | R/W                                 | 00h           |
| 27h   | CLK-GEN 3 Command Byte 3   | R/W                                 | 00h           |
| 28h   | CLK-GEN 3 Read Data Byte 0 | RO                                  | 00h           |
| 29h   | CLK-GEN 3 Read Data Byte 1 | RO                                  | 00h           |
| 2Ah   | CLK-GEN 3 Read Data Byte 2 | RO                                  | 00h           |
| 2Bh   | CLK-GEN 3 Read Data Byte 3 | RO                                  | 00h           |
| 2Fh~2Ch   | Reserved                   |                                     | 0s            |
| 3Fh~30h   | PM Bus (RFU)               | R/W                                 | 0s            |
| Note:   |                            |                                     |               |
| "**" means the value may be changed in the future FPGA FW update release. |                            |                                     |               |

# 5.6.2 FPGA Configuration Registers Descriptions

Register Address : SPI Base + 00h

Register Name : FPGA Device ID (Low Byte) Register

Default Value: 04h Attribute : Read Only

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | FPGA Device ID (Low Byte)  |            |
|     | This offset 01h field combined with this field identifies the      | DO.        |
|     | particular device. This identifier is allocated by the FPGA design | RO         |
|     | team.  |            |

Register Address : SPI Base + 01h

Register Name : FPGA Device ID (High Byte) Register

Default Value: 80h Attribute: Read Only

|     | - · · · · · · · · · · · · · · · · · · ·                            |            |
|-----|--|------------|
| Bit | Description  | Read/Write |
| 7-0 | FPGA Device ID (High Byte)   |            |
|     | This field combined with the offset 00h field identifies the       | DO.        |
|     | particular device. This identifier is allocated by the FPGA design | RO         |
|     | team.  |            |

Register Address : SPI Base + 02h

Register Name : FPGA Revision ID (Low Byte) Register

Default Value: \*\*

Attribute : Read Only

| Bit | Description                 | Read/Write |
|-----|-----------------------------|------------|
| 7-0 | FPGA Revision ID (Low Byte) | RO         |

| This offset 03h register combined with this register specifies the |  |
|--|--|
| FPGA device specific revision identifier. The value may be         |  |
| changed in the future FPGA FW update release.                      |  |

Register Address : SPI Base + 03h

Register Name : FPGA Revision ID (High Byte) Register

Default Value: 00h\* Attribute: Read Only

| Bit | Description   | Read/Write |
|-----|---|------------|
| 7-0 | FPGA Revision ID (High Byte)                                      |            |
|     | This register combined with the offset 02h register specifies the | DO.        |
|     | FPGA device specific revision identifier. The value may be        | RO         |
|     | changed in the future FPGA FW update release.                     |            |

Register Address : SPI Base + 04h

Register Name : BM GPI Status (07-00 Low Byte) Register

Default Value: ----

Attribute : Read Only

| Bit | Description  | Read/Write |
|-----|--|------------|
| 0   | BM GPIO 00 : This bit reflects the state of the BM general   |            |
|     | purpose input signal GPIO 00 and writes will have no effect. | RO         |
|     | 0 : BM GPIO 00 state is low                                  | KO         |
|     | 1 : BM GPIO 00 state is high                                 |            |
| 1   | BM GPIO 01: This bit reflects the state of the BM general    |            |
|     | purpose input signal GPIO 01 and writes will have no effect. | RO         |
|     | 0 : BM GPIO 01 state is low                                  | NO         |
|     | 1 : BM GPIO 01 state is high                                 |            |
| 2   | BM GPIO 02: This bit reflects the state of the BM general    |            |
|     | purpose input signal GPIO 02 and writes will have no effect. | RO         |
|     | 0 : BM GPIO 02 state is low                                  | NO NO      |
|     | 1 : BM GPIO 02 state is high                                 |            |
| 3   | BM GPIO 03: This bit reflects the state of the BM general    |            |
|     | purpose input signal GPIO 03 and writes will have no effect. | RO         |
|     | 0 : BM GPIO 03 state is low                                  | I NO       |
|     | 1 : BM GPIO 03 state is high                                 |            |
| 4   | BM GPIO 04 : This bit reflects the state of the BM general   |            |
|     | purpose input signal GPIO 04 and writes will have no effect. | RO         |
|     | 0 : BM GPIO 04 state is low                                  | INO        |
|     | 1 : BM GPIO 04 state is high                                 |            |
| 5   | BM GPIO 05 : This bit reflects the state of the BM general   |            |
|     | purpose input signal GPIO 05 and writes will have no effect. | RO         |
|     | 0 : BM GPIO 05 state is low                                  | I.O        |
|     | 1 : BM GPIO 05 state is high                                 |            |
| 6   | BM GPIO 06: This bit reflects the state of the BM general    |            |
|     | purpose input signal GPIO 06 and writes will have no effect. | RO         |
|     | 0 : BM GPIO 06 state is low                                  | I.O        |
|     | 1 : BM GPIO 06 state is high                                 |            |

| 7 | BM GPIO 07: This bit reflects the state of the BM general    |    |
|---|--|----|
|   | purpose input signal GPIO 07 and writes will have no effect. | RO |
|   | 0 : BM GPIO 07 state is low                                  | KU |
|   | 1 : BM GPIO 07 state is high                                 |    |

Register Address : SPI Base + 05h

Register Name : BM GPI (15-08 High Byte) Status Register

Default Value: ----

Attribute : Read Only

| Attribute | ,  |            |
|-----------|--|------------|
| Bit       | Description  | Read/Write |
| 0         | BM GPIO 08: This bit reflects the state of the BM general    |            |
|           | purpose input signal GPIO 08 and writes will have no effect. | RO         |
|           | 0 : BM GPIO 08 state is low                                  | I.O        |
|           | 1 : BM GPIO 08 state is high                                 |            |
| 1         | BM GPIO 09: This bit reflects the state of the BM general    |            |
|           | purpose input signal GPIO 09 and writes will have no effect. | RO         |
|           | 0 : BM GPIO 09 state is low                                  | I NO       |
|           | 1 : BM GPIO 09 state is high                                 |            |
| 2         | BM GPIO 10: This bit reflects the state of the BM general    |            |
|           | purpose input signal GPIO 10 and writes will have no effect. | RO         |
|           | 0 : BM GPIO 10 state is low                                  | NO NO      |
|           | 1 : BM GPIO 10 state is high                                 |            |
| 3         | BM GPIO 11: This bit reflects the state of the BM general    |            |
|           | purpose input signal GPIO 11 and writes will have no effect. | RO         |
|           | 0 : BM GPIO 11 state is low                                  | NO NO      |
|           | 1 : BM GPIO 11 state is high                                 |            |
| 4         | BM GPIO 12: This bit reflects the state of the BM general    |            |
|           | purpose input signal GPIO 12 and writes will have no effect. | RO         |
|           | 0 : BM GPIO 12 state is low                                  | NO NO      |
|           | 1 : BM GPIO 12 state is high                                 |            |
| 5         | BM GPIO 13: This bit reflects the state of the BM general    |            |
|           | purpose input signal GPIO 13 and writes will have no effect. | RO         |
|           | 0 : BM GPIO 13 state is low                                  | , KO       |
|           | 1 : BM GPIO 13 state is high                                 |            |
| 6         | BM GPIO 14: This bit reflects the state of the BM general    |            |
|           | purpose input signal GPIO 14 and writes will have no effect. | RO         |
|           | 0 : BM GPIO 14 state is low                                  | , KO       |
|           | 1 : BM GPIO 14 state is high                                 |            |
| 7         | BM GPIO 15: This bit reflects the state of the BM general    |            |
|           | purpose input signal GPIO 15 and writes will have no effect. | DO.        |
|           | 0 : BM GPIO 15 state is low                                  | RO         |
|           | 1 : BM GPIO 15 state is high                                 |            |
|           |  |            |

Register Address : SPI Base + 06h

Register Name : DSP GPI (07-00 Low Byte) Register

Default Value: ----

Attribute : Read Only

| Bit | Description  | Read/Write |
|-----|--|------------|
| 0   | DSP GPIO 00 : This bit reflects the state of the DSP general |            |
|     | purpose input signal GPIO 00 and writes will have no effect. | RO         |
|     | 0 : DSP GPIO 00 state is low                                 | , KO       |
|     | 1 : DSP GPIO 00 state is high                                |            |
| 1   | DSP GPIO 01: This bit reflects the state of the DSP general  |            |
|     | purpose input signal GPIO 01 and writes will have no effect. | RO         |
|     | 0 : DSP GPIO 01 state is low                                 | I NO       |
|     | 1 : DSP GPIO 01 state is high                                |            |
| 2   | DSP GPIO 02: This bit reflects the state of the DSP general  |            |
|     | purpose input signal GPIO 02 and writes will have no effect. | RO         |
|     | 0 : DSP GPIO 02 state is low                                 | 110        |
|     | 1 : DSP GPIO 02 state is high                                |            |
| 3   | DSP GPIO 03: This bit reflects the state of the DSP general  |            |
|     | purpose input signal GPIO 03 and writes will have no effect. | RO         |
|     | 0 : DSP GPIO 03 state is low                                 | 110        |
|     | 1 : DSP GPIO 03 state is high                                |            |
| 4   | DSP GPIO 04: This bit reflects the state of the DSP general  |            |
|     | purpose input signal GPIO 04 and writes will have no effect. | RO         |
|     | 0 : DSP GPIO 04 state is low                                 | 110        |
|     | 1 : DSP GPIO 04 state is high                                |            |
| 5   | DSP GPIO 05: This bit reflects the state of the DSP general  |            |
|     | purpose input signal GPIO 05 and writes will have no effect. | RO         |
|     | 0 : DSP GPIO 05 state is low                                 | 110        |
|     | 1 : DSP GPIO 05 state is high                                |            |
| 6   | DSP GPIO 06: This bit reflects the state of the DSP general  |            |
|     | purpose input signal GPIO 06 and writes will have no effect. | RO         |
|     | 0 : DSP GPIO 06 state is low                                 | 11.0       |
|     | 1 : DSP GPIO 06 state is high                                |            |
| 7   | DSP GPIO 07: This bit reflects the state of the DSP general  |            |
|     | purpose input signal GPIO 07 and writes will have no effect. | RO         |
|     | 0 : DSP GPIO 07 state is low                                 |            |
|     | 1 : DSP GPIO 07 state is high                                |            |

Register Address : SPI Base + 07h

Register Name : DSP GPI (15-08 High Byte) Status Register

Default Value: 00h Attribute: Read Only

| Bit | Description  | Read/Write |
|-----|--|------------|
| 0   | DSP GPIO 08: This bit reflects the state of the DSP general  |            |
|     | purpose input signal GPIO 08 and writes will have no effect. | P.O        |
|     | 0 : DSP GPIO 08 state is low                                 | RO         |
|     | 1 : DSP GPIO 08 state is high                                |            |
| 1   | DSP GPIO 09: This bit reflects the state of the DSP general  |            |
|     | purpose input signal GPIO 09 and writes will have no effect. | D.O.       |
|     | 0 : DSP GPIO 09 state is low                                 | RO         |
|     | 1 : DSP GPIO 09 state is high                                |            |

| 2 | DSP GPIO 10 : This bit reflects the state of the DSP general |      |
|---|--|------|
|   | purpose input signal GPIO 10 and writes will have no effect. | RO   |
|   | 0 : DSP GPIO 10 state is low                                 |      |
|   | 1 : DSP GPIO 10 state is high                                |      |
| 3 | DSP GPIO 11: This bit reflects the state of the DSP general  |      |
|   | purpose input signal GPIO 11 and writes will have no effect. | P.O  |
|   | 0 : DSP GPIO 11 state is low                                 | RO   |
|   | 1 : DSP GPIO 11 state is high                                |      |
| 4 | DSP GPIO 12: This bit reflects the state of the DSP general  |      |
|   | purpose input signal GPIO 12 and writes will have no effect. | DO.  |
|   | 0 : DSP GPIO 12 state is low                                 | RO   |
|   | 1 : DSP GPIO 12 state is high                                |      |
| 5 | DSP GPIO 13: This bit reflects the state of the DSP general  |      |
|   | purpose input signal GPIO 13 and writes will have no effect. | DO.  |
|   | 0 : DSP GPIO 13 state is low                                 | RO   |
|   | 1 : DSP GPIO 13 state is high                                |      |
| 6 | DSP GPIO 14: This bit reflects the state of the DSP general  |      |
|   | purpose input signal GPIO 14 and writes will have no effect. | D.O. |
|   | 0 : DSP GPIO 14 state is low                                 | RO   |
|   | 1 : DSP GPIO 14 state is high                                |      |
| 7 | DSP GPIO 15 : This bit reflects the state of the DSP general |      |
|   | purpose input signal GPIO 15 and writes will have no effect. | P.O. |
|   | 0 : DSP GPIO 15 state is low                                 | RO   |
|   | 1 : DSP GPIO 15 state is high                                |      |
|   | <u>.</u>   |      |

Register Address : SPI Base + 08h
Register Name : Debug LED Register

Default Value: 00h

| Bit | Description  | Read/Write |
|-----|--|------------|
| 0   | DEBUG_LED 1 : This bit can be updated by the DSP software to | R/W        |
|     | drive a high or low value on the debug LED 1 pin.            |            |
|     | 0 : DEBUG_LED 1 drives low and set the LED 1 to ON.          | IX) VV     |
|     | 1: DEBUG_LED 1 drives high and set the LED 1 to OFF.         |            |
| 1   | DEBUG_LED 2 : This bit can be updated by the DSP software to |            |
|     | drive a high or low value on the debug LED 2 pin.            | R/W        |
|     | 0 : DEBUG_LED 2 drives low and set the LED 2 to ON.          | IX) VV     |
|     | 1: DEBUG_LED 2 drives high and set the LED 2 to OFF.         |            |
| 2   | DEBUG_LED 3: This bit can be updated by the DSP software to  | R/W        |
|     | drive a high or low value on the debug LED 3 pin             |            |
|     | 0 : DEBUG_LED 3 drives low and set the LED 3 to ON.          |            |
|     | 1: DEBUG_LED 3 drives high and set the LED 3 to OFF.         |            |
| 3   | DEBUG_LED 4: This bit can be updated by the DSP software to  |            |
|     | drive a high or low value on the debug LED 4 pin             | R/W        |
|     | 0 : DEBUG_LED 4 drives low and set the LED 4 to ON.          |            |
|     | 1 : DEBUG_LED 4 drives high and set the LED 4 to OFF.        |            |
| 7-4 | Reserved   | RO         |

Register Address : SPI Base + 09h

Register Name : MMC Control Register

Default Value: ----

Attribute : Read Only

| Bit | Description  | Read/Write |
|-----|--|------------|
| 0   | MMC_DETECT# : This bit reflects the MMC_DETECT# state and it     |            |
|     | is used by the MMC to indicate the AMC chassis insertion status. |            |
|     | 0 : MMC_DETECT# state is low to indicate that the EVM is         | RO         |
|     | inserted into the AMC chassis.                                   | 11.0       |
|     | 1 : MMC_DETECT# state is high to indicate that the EVM is not    |            |
|     | inserted into the AMC chassis.                                   |            |
| 1   | MMC_RESETSTAT#: This bit reflects the DSP RESETSTAT# state       |            |
|     | and the FPGA will drive the same logic value on the              |            |
|     | MMC_RESETSTAT# pin ( to MMC ).                                   |            |
|     | 0 : DSP RESETSTAT# state is low and the FPGA drives              | RO         |
|     | MMC_RESETSTAT# low to MMC  |            |
|     | 1 : DSP RESETSTAT# state is high and the FPGA drives             |            |
|     | MMC_RESETSTAT# high to MMC                                       |            |
| 2   | MMC_POR_IN_AMC# : This bit reflects the                          |            |
|     | MMC_POR_IN_AMC# state and it is used by the MMC to trigger       |            |
|     | a Power-On sequence & reset event.                               |            |
|     | 0 : MMC_POR_IN_AMC# state is low to trigger a Power-On           | RO         |
|     | sequence & reset event.  |            |
|     | 1: MMC_POR_IN_AMC# state is high and the FPGA stays in           |            |
|     | current state.   |            |
| 3   | MMC_WR_AMC# : This bit reflects the MMC_WR_AMC# state            |            |
|     | and it is used by the MMC to trigger a warm reset event.         | _          |
|     | 0 : MMC_WR_AMC# state is low to trigger a warm reset event.      | RO         |
|     | 1: MMC_WR_AMC# state is high and the FPGA stays in current       |            |
|     | state  |            |
| 4   | MMC_BOOTCOMPLETE: This bit reflects the                          |            |
|     | DSP_BOOTCOMPLETE state and the FPGA will drive the same          |            |
|     | logic value on the MMC_ BOOTCOMPLETE pin ( to MMC ).             |            |
|     | 0 : DSP_BOOTCOMPLETE state is low and the FPGA drives MMC_       | RO         |
|     | BOOTCOMPLETE low to MMC  |            |
|     | 1 : DSP_BOOTCOMPLETE state is high and the FPGA drives           |            |
|     | MMC_ BOOTCOMPLETE high to MMC                                    |            |
| 7-5 | Reserved   | RO         |

Register Address : SPI Base + 0Ah
Register Name : PHY Control Register

Default Value: 03h

| Bit | Description                                     | Read/Write |
|-----|---|------------|
| 0   | PHY_INT#: This bit reflects the PHY_INT# state. | DQ.        |
|     | 0 : PHY_INT# state is low.                      | RO         |

|     | 1: PHY_INT# state is high.                                     |      |
|-----|--|------|
| 1   | PHY_RST#: This bit can be updated by the DSP software to drive |      |
|     | a high or low value on the PHY_RST# pin                        | R/W  |
|     | 0 : PHY_RST# drives low  | K/VV |
|     | 1 : PHY_RST# drives high                                       |      |
| 7-3 | Reserved   | RO   |

Register Address : SPI Base + 0Bh

Register Name : Reset Button Status Register

Default Value: ----

Attribute : Read Only

| Bit | Description   | Read/Write |
|-----|---|------------|
| 0   | FULL RESET button status : This bit reflects the FULL RESET     | •          |
|     | button state. This button is used to request a power full reset |            |
|     | sequence to DSP. A logic Low to High transition on this button  |            |
|     | signal will complete the FPGA FULL_RESET sequence with a        | RO         |
|     | specified delay time.   |            |
|     | 0 : FULL_RESET button state is low                              |            |
|     | 1 : FULL_RESET button state is high                             |            |
| 1   | WARM_RESET button status : This bit reflects the WARM _RESET    |            |
|     | button state. This button is used to request a warm reset       |            |
|     | sequence to DSP. A logic Low to High transition on this button  |            |
|     | signal will complete the FPGA WARM_RESET sequence with a        | RO         |
|     | specified delay time.   |            |
|     | 0 : WARM_RESET button state is low                              |            |
|     | 1 : WARM_RESET button state is high                             |            |
| 2   | COLD_RESET button status (RFU): This bit reflects the COLD      |            |
|     | _RESET button state. This button is not used in current         |            |
|     | implementation.   | RO         |
|     | 0 : COLD_RESET button state is low                              |            |
|     | 1 : COLD_RESET button state is high                             |            |
| 3   | FPGA_JTAG_RST#  |            |
|     | 0 : FPGA_JTAG_RST# state is low                                 | RO         |
|     | 1 : FPGA_JTAG_RST# state is high                                |            |
| 4   | DSP_RESETSTAT#: This bit reflects the DSP_RESETSTAT# state.     |            |
|     | 0 : DSP_RESETSTAT# state is low                                 | RO         |
|     | 1 : DSP_RESETSTAT# state is high                                |            |
| 5   | TRGRSTZ: This bit reflects the TRGRSTZ state.                   |            |
|     | 0 : TRGRSTZ state is low  | RO         |
|     | 1 : TRGRSTZ state is high                                       |            |
| 6   | PCIESSEN: This bit reflects the PCIESSEN switch state.          |            |
|     | 0 : PCIESSEN state is low                                       | RO         |
|     | 1 : PCIESSEN state is high                                      |            |
| 7   | User_Defined Switch : This bit reflects the User_Define Switch  |            |
|     | state.  | RO         |
|     | 0 : User_Defined Switch state is low                            | NO         |
|     | 1 : User_Defined Switch state is high                           |            |

Register Address : SPI Base + 0Ch

Register Name : Miscellaneous - 1 Register

Default Value: 1Ch

Attribute : Read/Write

| Bit | Description   | Read/Write |
|-----|---|------------|
| 1-0 | Reserved  | R/W        |
| 2   | NAND_WP#: This bit can be updated by the DSP software to drive a high or low value on the NAND_WP# pin 0: NAND_WP# drives low 1: NAND_WP# drives high                           | R/W        |
| 3   | XDS560_IL control 0: Disable XDS560 mezzanine card 1: Enable XDS560 mezzanine card (Default)  | R/W        |
| 4   | NOR_WP#: This bit can be updated by the DSP software to drive a high or low value on the NOR_WP# pin 0: NOR_WP# drives low 1: NOR_WP# drives high                               | R/W        |
| 5   | EEPROM_WP: This bit can be updated by the DSP software to drive a high or low value on the EEPROM_WP pin 0: EEPROM_WP drives low 1: EEPROM_WP drives high                       | R/W        |
| 6   | PCA9306_EN: This bit can be updated by the DSP software to drive a high or low value on the PCA9306_EN pin (RFU)  0: PCA9306_EN drives low (Default)  1: PCA9306_EN drives high | R/W        |
| 7   | Reserved  | RO         |

Register Address : SPI Base + 0Dh

Register Name : Miscellaneous - 2 Register

Default Value: ----

Attribute : Read Only

| Bit | Description   | Read/Write |
|-----|---|------------|
| 0   | FPGA FW Update SPI Interface Enable Status: This bit reflects the FPGA FW Update SPI Interface Enable status. The FPGA FW |            |
|     | Update SPI interface could be enabled/disabled through the offset OEh register.   |            |
|     | 0 : FPGA FW update SPI interface is disabled.   | RO         |
|     | 1 : FPGA FW update SPI interface is enabled.  | 1.0        |
|     | The DSP_GPIO[12] is mapped to FPGA_FW_SPI_CLK.  |            |
|     | The DSP_GPIO[13] is mapped to FPGA_FW_SPI_CS#.  |            |
|     | The DSP_GPIO[14] is mapped to FPGA_FW_SPI_MOSI.   |            |
|     | The DSP_GPIO[15] is mapped to FPGA_FW_SPI_MISO.   |            |
| 2   | DSP_HOUT status: This bit reflects the DSP_HOUT signal state.   |            |
|     | 0 : DSP_HOUT state is low   | RO         |
|     | 1 : DSP_HOUT state is high  |            |
| 3   | DSP_SYSCLKOUT status : This bit reflects the DSP_SYSCLKOUT  | RO         |

|     | signal state.                   |    |
|-----|---------------------------------|----|
|     | 0 : DSP_SYSCLKOUT state is low  |    |
|     | 1 : DSP_SYSCLKOUT state is high |    |
| 7-4 | Reserved                        | RO |

Register Address : SPI Base + 0Eh

Register Name : FPGA FW Update SPI Interface Control Register

Default Value: 00h Attribute : Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | FPGA FW Update SPI Interface Enable Control: These bits are      |            |
|     | used to enable/disable the FPGA FW Update SPI Interface. If      |            |
|     | the value of this register be set to 68h, the FPGA FW Update SPI |            |
|     | interface would be enabled. All the other values set to this     |            |
|     | register would disable the FPGA FW Update SPI interface.         |            |
|     | 68h : FPGA FW update SPI interface is enabled.                   | R/W        |
|     | Others: FPGA FW update SPI interface is disabled.                |            |
|     | The DSP_GPIO[12] is mapped to FPGA_FW_SPI_CLK.                   |            |
|     | The DSP_GPIO[13] is mapped to FPGA_FW_SPI_CS#.                   |            |
|     | The DSP_GPIO[14] is mapped to FPGA_FW_SPI_MOSI.                  |            |
|     | The DSP_GPIO[15] is mapped to FPGA_FW_SPI_MISO.                  |            |

Register Address : SPI Base + 0Fh
Register Name : Scratch Register
Default Value: 00h

Attribute : Read/Write

| Bi | t | Description  | Read/Write |
|----|---|--------------|------------|
| 7- | 0 | Scratch Data | R/W        |

Register Address : SPI Base + 10h

Register Name : CLK-GEN 2 Control Register

Default Value: 00h

Attribute: Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 0   | Initiate a data transfer via the SPI bus to update the SPI command to CDCE62005 Clock Generator #2 0: Idle state 1: Write 1 to perform the SPI command update process.   | R/W        |
| 1   | The BUSY status indication for the CDCE62005 Clock Generator #2 SPI bus  0: The SPI bus for the CDCE62005 Clock Generator #2 is idle.  1: The SPI bus for the CDCE62005 Clock Generator #2 is busy and a SPI command is processing | RO         |
| 7-2 | Reserved   | RO         |

Register Address : SPI Base + 11h

Register Name : CLK-GEN 2 Interface Clock Setting Register

Default Value: 03h

Attribute : Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register is a clock divider setting to adjust the interface |            |
|     | clock for the CDCE62005 Clock Generator #2 SPI bus.              |            |
|     | 00 : CDCE62005 2 SPI Clock = 12MHz ( = 48 / 4 )                  |            |
|     | 01 : CDCE62005 2 SPI Clock = 12MHz ( = 48 / 4 )                  |            |
|     | 02 : CDCE62005 2 SPI Clock = 8 MHz ( = 48 / 6 )                  |            |
|     | 03 : CDCE62005 2 SPI Clock = 6 MHz ( = 48 / 8 )                  | R/W        |
|     | 04 : CDCE62005 2 SPI Clock = 4.8 MHz ( = 48 /10 )                |            |
|     | 05 : CDCE62005 2 SPI Clock = 4 MHz ( = 48 /12 )                  |            |
|     | 06 : CDCE62005 2 SPI Clock = 3.42 MHz ( = 48 / 14)               |            |
|     |  |            |
|     | X : CDCE62005 2 SPI Clock = 48 MHz /((X+1)*2) if X != 0          |            |

Register Address : SPI Base + 12h ~ 13h

Register Name : Reserved

Register Address : SPI Base + 14h

Register Name : CLK-GEN 2 Command Byte 0 Register

Default Value: 00h

Attribute : Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register specifies the update SPI command byte 0 to the |            |
|     | CDCE62005 Clock Generator #2                                 | D /\A/     |
|     | 3-0 : SPI command address field bit 3 to bit 0               | R/W        |
|     | 7-4 : SPI command data field bit 3 to bit 0                  |            |

Register Address : SPI Base + 15h

Register Name : CLK-GEN 2 Command Byte 1 Register

Default Value: 00h Attribute : Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register specifies the update SPI command byte 1 to the |            |
|     | CDCE62005 Clock Generator #2                                 | R/W        |
|     | 7-0 : SPI command data field bit 11 to bit 4                 |            |

Register Address : SPI Base + 16h

Register Name: CLK-GEN 2 Command Byte 2 Register

Default Value: 00h

Attribute : Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register specifies the update SPI command byte 2 to the |            |
|     | CDCE62005 Clock Generator #2                                 | R/W        |
|     | 7-0 : SPI command data field bit 19 to bit12                 |            |

Register Address : SPI Base + 17h

Register Name : CLK-GEN 2 Command Byte 3 Register

Default Value: 00h

Attribute: Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register specifies the update SPI command byte 3 to the |            |
|     | CDCE62005 Clock Generator #2                                 | R/W        |
|     | 7-0 : SPI command data field bit 27 to bit 20                |            |

Register Address : SPI Base + 18h

Register Name : CLK-GEN 2 Read Data Byte 0 Register

Default Value: 00h Attribute: Read Only

| Bit | Description   | Read/Write |
|-----|---|------------|
| 7-0 | This register reflects the read back data byte 0 from the   |            |
|     | CDCE62005 Clock Generator #2 for responding a host SPI Read |            |
|     | Command.  | RO         |
|     | 7-0 : The SPI read back data bit 7 to bit 0 for a SPI Read  |            |
|     | Command.  |            |

Register Address : SPI Base + 19h

Register Name : CLK-GEN 2 Read Data Byte 1 Register

Default Value: 00h Attribute: Read Only

| Bit | Description   | Read/Write |
|-----|---|------------|
| 7-0 | This register reflects the read back data byte 1 from the   |            |
|     | CDCE62005 Clock Generator #2 for responding a host SPI Read |            |
|     | Command.  | RO         |
|     | 7-0 : The SPI read back data bit 15 to bit 8 for a SPI Read |            |
|     | Command.  |            |

Register Address : SPI Base + 1Ah

Register Name : CLK-GEN 2 Read Data Byte 2 Register

Default Value: 00h Attribute: Read Only

| Bit | Description   | Read/Write |
|-----|---|------------|
| 7-0 | This register reflects the read back data byte 1 from the   |            |
|     | CDCE62005 Clock Generator #2 for responding a host SPI Read |            |
|     | Command.  | RO         |
|     | 7-0: The SPI read back data bit 23 to bit 16 for a SPI Read |            |
|     | Command.  |            |

Register Address : SPI Base + 1Bh

Register Name: CLK-GEN 2 Read Data Byte 3 Register

Default Value: 00h

| Bit | Description   | Read/Write |
|-----|---|------------|
| 7-0 | This register reflects the read back data byte 1 from the | RO         |

| CDCE62005 Clock Generator #2 for responding a host SPI Read  |  |
|--|--|
| Command.   |  |
| 3-0 : The SPI read back data bit 27 to bit 24 for a SPI Read |  |
| Command.   |  |
| 7-4 : Reserved   |  |

Register Address : SPI Base + 1Ch ~ 1Fh

Register Name : Reserved

Register Address : SPI Base + 20h

Register Name : CLK-GEN 3 Control Register

Default Value: 00h

Attribute : Read/Write

| Bit | Description   | Read/Write |
|-----|---|------------|
| 0   | Initiate a data transfer via the SPI bus to update the SPI    |            |
|     | command to CDCE62005 Clock Generator #3                       | D /\A/     |
|     | 0 : Idle state  | R/W        |
|     | 1: Write 1 to perform the SPI command update process.         |            |
| 1   | The BUSY status indication for the CDCE62005 Clock Generator  |            |
|     | #3 SPI bus  |            |
|     | 0 : The SPI bus for the CDCE62005 Clock Generator #3 is idle. | RO         |
|     | 1 : The SPI bus for the CDCE62005 Clock Generator #3 is busy  |            |
|     | and a SPI command is processing.                              |            |
| 7-2 | Reserved  | RO         |

Register Address : SPI Base + 21h

Register Name : CLK-GEN 3 Interface Clock Setting Register

Default Value: 00h

Attribute : Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register is a clock divider setting to adjust the interface |            |
|     | clock for the CDCE62005 Clock Generator #3 SPI bus.              |            |
|     | 00 : CDCE62005#3 SPI Clock = 12MHz ( = 48 / 4 )                  |            |
|     | 01 : CDCE62005#3 SPI Clock = 12MHz ( = 48 / 4 )                  |            |
|     | 02 : CDCE62005#3 SPI Clock = 8 MHz ( = 48 / 6 )                  |            |
|     | 03 : CDCE62005#3 SPI Clock = 6 MHz ( = 48 / 8 )                  | R/W        |
|     | 04 : CDCE62005#3 SPI Clock = 4.8 MHz ( = 48 /10 )                |            |
|     | 05 : CDCE62005#3 SPI Clock = 4 MHz ( = 48 /12 )                  |            |
|     | 06 : CDCE62005#3 SPI Clock = 3.42 MHz ( = 48 / 14)               |            |
|     |  |            |
|     | X : CDCE62005#3 SPI Clock = 48 MHz /((X+1)*2) if X != 0          |            |

Register Address : SPI Base + 22h ~ 23h

Register Name : Reserved

Register Address : SPI Base + 24h

Register Name : CLK-GEN 3 Command Byte 0 Register

Default Value: 00h

Attribute : Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register specifies the update SPI command byte 0 to the |            |
|     | CDCE62005 Clock Generator #3                                 | R/W        |
|     | 3-0 : SPI command address field bit 3 to bit 0               | K/VV       |
|     | 7-4 : SPI command data field bit 3 to bit 0                  |            |

Register Address : SPI Base + 25h

Register Name : CLK-GEN 2 Command Byte 1 Register

Default Value: 00h

Attribute : Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register specifies the update SPI command byte 1 to the |            |
|     | CDCE62005 Clock Generator #3                                 | R/W        |
|     | 7-0 : SPI command data field bit 11 to bit 4                 |            |

Register Address : SPI Base + 26h

Register Name: CLK-GEN 3 Command Byte 2 Register

Default Value: 00h Attribute: Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register specifies the update SPI command byte 2 to the |            |
|     | CDCE62005 Clock Generator #3                                 | R/W        |
|     | 7-0 : SPI command data field bit 19 to bit 12                |            |

Register Address : SPI Base + 27h

Register Name: CLK-GEN 3 Command Byte 3 Register

Default Value: 00h Attribute : Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register specifies the update SPI command byte 3 to the |            |
|     | CDCE62005 Clock Generator #3                                 | R/W        |
|     | 7-0 : SPI command data field bit 27 to bit 20                |            |

Register Address : SPI Base + 28h

Register Name : CLK-GEN 3 Read Data Byte 0 Register

Default Value: 00h Attribute: Read Only

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register reflects the read back data byte 0 from the    |            |
|     | CDCE62005 Clock Generator #3 for responding to a host SPI    |            |
|     | Read Command.  |            |
|     | 3-0: The SPI read back register address [3-0] for a SPI Read | RO         |
|     | Command  |            |
|     | 7-4 : The SPI read back data bit 3 to bit 0 for a SPI Read   |            |
|     | Command.   |            |

Register Address : SPI Base + 29h

Register Name : CLK-GEN 3 Read Data Byte 1 Register

Default Value: 00h Attribute: Read Only

| Bit | Description   | Read/Write |
|-----|---|------------|
| 7-0 | This register reflects the read back data byte 1 from the   |            |
|     | CDCE62005 Clock Generator #3 for responding to a host SPI   |            |
|     | Read Command.   | RO         |
|     | 7-0 : The SPI read back data bit 11 to bit 4 for a SPI Read |            |
|     | Command.  |            |

Register Address : SPI Base + 2Ah

Register Name : CLK-GEN 3 Read Data Byte 2 Register

Default Value: 00h Attribute: Read Only

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register reflects the read back data byte 1 from the    |            |
|     | CDCE62005 Clock Generator #3 for responding to a host SPI    |            |
|     | Read Command.  | RO         |
|     | 7-0 : The SPI read back data bit 19 to bit 12 for a SPI Read |            |
|     | Command.   |            |

Register Address : SPI Base + 2Bh

Register Name: CLK-GEN 3 Read Data Byte 3 Register

Default Value: 00h

Attribute : Read/Write

| Bit | Description  | Read/Write |
|-----|--|------------|
| 7-0 | This register reflects the read back data byte 1 from the    |            |
|     | CDCE62005 Clock Generator #3 for responding to a host SPI    |            |
|     | Read Command.  | RO         |
|     | 7-0 : The SPI read back data bit 27 to bit 20 for a SPI Read |            |
|     | Command.   |            |

Register Address : SPI Base + 2Ch ~ 2Fh

Register Name : Reserved

Register Address : SPI Base + 30h ~ 3Fh(TBD)
Register Name : PM Bus Control Register

Default Value: 00h

| Bit | Description | Read/Write |
|-----|-------------|------------|
| 7-0 | TBD         | R/W        |

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